

## Smart Cap Divider Charger

### General Description

The RT9759 is a high efficiency and high charge current charger. The efficiency is up to 97.8% when VBAT = 4.2V, IBAT = 2.5A and the maximum charge current is up to 8A. The device integrates smart cap divider topology, external over-voltage protection control, an input reverse blocking NFET and 2-way regulation, a dual-phase charge pump core, 15-way protection, 7-way system alarm and 9-Channel high speed analog-to-digital converter. The high speed analog-to-digital converter provides input and output voltage, current and temperature information for the host. The host can monitor the information by I<sup>2</sup>C serial interface.

### Applications

- Smart Phones
- Tablet
- PC

### Ordering Information

RT9759 □  
 □ Package Type  
 WSC : WL-CSP-56B 3.35x3.35 (BSC)

Note :

Richtek products are :

- ▶ RoHS compliant and compatible with the current requirements of IPC/JEDEC J-STD-020.
- ▶ Suitable for use in SnPb or Pb-free soldering processes.

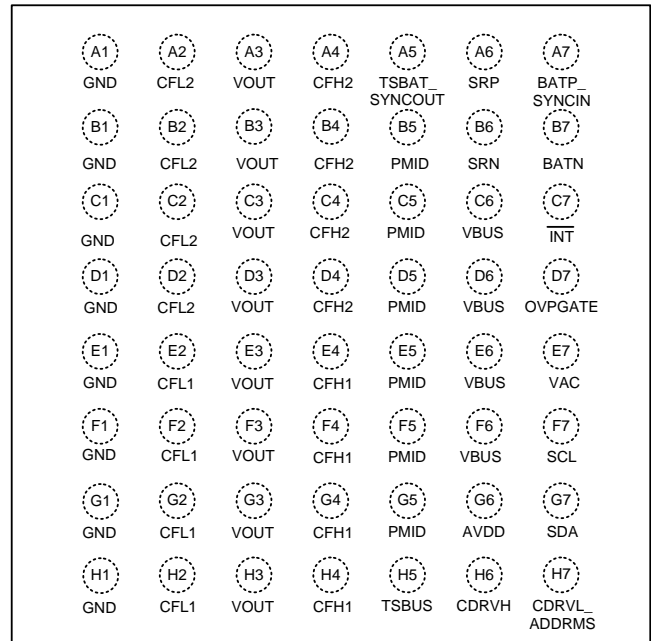
### Features

- **External OVP Control and Regulation**
  - ▶ High Absolute Maximum Rating of 40V
  - ▶ Fast Reaction Time 100ns and Fast Turn Off Time 100ns
  - ▶ VBAT Voltage Regulation (VBAT REG)
  - ▶ IBAT Current Regulation (IBAT REG)
- **Input Reverse Blocking NFET**
  - ▶ Block the Reverse Current
- **Dual-Phase Charge Pump Core**
  - ▶ 8A Output Current Capability
  - ▶ Efficiency Up to 97.8% when VBAT = 4.2V, IBAT = 2.5A
  - ▶ 250kHz to 750kHz Variable Switching Frequency Stay Out of Audio Band
  - ▶ Spread Spectrum Technology for EMI Reduction
- **4-Error Charge Pump Switch Protection**
  - ▶ VBUS Voltage Too High Error Protection before Switch (VBUS\_HIGH\_ERR)
  - ▶ VBUS Voltage Too Low Error Protection before Switch (VBUS\_LOW\_ERR)
  - ▶ CFLY Short Error Protection Before Switch (CFLY\_DIAG)
  - ▶ NFET Over-Current Error Protection During Switch (CON\_OCP)
- **10-Way System Protection**
  - ▶ VBUS Over-Voltage Protection (VBUS\_OVP)
  - ▶ IBUS Over-Current Protection (IBUS\_OCP)
  - ▶ IBUS Under-Current Protection (IBUS\_UCP)
  - ▶ VOUT Over-Voltage Protection (VOUT\_OVP)
  - ▶ VBAT Over-Voltage Protection (VBAT\_OVP)
  - ▶ IBAT Over-Current Protection (IBAT\_OCP)
  - ▶ Dropout Over-Voltage Protection (VDR\_OVP)
  - ▶ TSBUS Over-Temperature Protection (TBUS\_OTP)
  - ▶ TSBAT Over-Temperature Protection (TBAT\_OTP)
  - ▶ Junction Over-Temperature Protection (TDIE\_OTP)
- **7-Way System Alarm**
  - ▶ VBUS Over-Voltage Alarm (VBUS\_OVP\_ALM)
  - ▶ IBUS Over-Current Alarm (IBUS\_OCP\_ALM)

- ▶ VBAT Over-Voltage Alarm (VBAT\_OVP\_ALM)
- ▶ IBAT Over-Current Alarm (IBAT\_OCP\_ALM)
- ▶ IBAT Under-Current Alarm (IBAT\_UCP-ALM)
- ▶ TSBUS and TSBAT Over-Temperature Alarm (TBUS\_TSBAT\_OTP\_ALM)
- ▶ TDIE Over-Temperature Alarm (TDIE\_OTP\_ALM)
- 9-Channel 12-bit ADC
  - ▶ High Speed Data Rate for 128 Times Average Per Channel
  - ▶ VBUS, IBUS, VOUT, VBAT, IBAT, TSBUS, TSBAT, TDIE, VAC 9-Channel for Voltage/Current Measurement

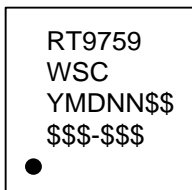
## Pin Configuration

(TOP VIEW)



WL-CSP-56B 3.35x3.35 (BSC)

## Marking Information



RT9759WSC : Product Number

YMDNN : Date Code

\$ : Random Code

## Functional Pin Description

| Pin No.                        | Pin Name      | I/O | Pin Function  |
|--------------------------------|---------------|-----|---|
| A1, B1, C1, D1, E1, F1, G1, H1 | GND           | P   | Power ground.   |
| A2, B2, C2, D2                 | CFL2          | P   | Flying capacitor negative node. Three 22 $\mu$ F capacitors must be connected to CFL2 and CFH2 and placed as close as possible to the device. These pins must be connected together on the PCB. |
| E2, F2, G2, H2                 | CFL1          | P   | Flying capacitor negative node. Three 22 $\mu$ F capacitors must be connected to CFL1 and CFH1 and placed as close as possible to the device. These pins must be connected together on the PCB. |
| A3, B3, C3, D3, E3, F3, G3, H3 | VOUT          | P   | Power supply. Connect to positive terminal of the battery pack. Must be connected together on the PCB. Two 10 $\mu$ F capacitors must be connected to VOUT and GND.                             |
| A4, B4, C4, D4                 | CFH2          | P   | Flying capacitor positive node. Three 22 $\mu$ F capacitors must be connected to CFL2 and CFH2 and placed as close as possible to the device. These pins must be connected together on the PCB. |
| A5                             | TSBAT_SYNCOUT | AI  | Battery temperature qualification voltage input. Requires external resistor divider and voltage reference. In parallel configuration, connect this pin to BATP_SYNCIN of slave.                 |
| A6                             | SRP           | AI  | Positive input for battery current sensing. Place 5m $\Omega$ or 2m $\Omega$ between SRN and SRP.   |
| A7                             | BATP_SYNCIN   | AI  | Positive input for battery voltage sensing. Connect 100 $\Omega$ in series with positive terminal of battery pack. In parallel configuration, connect this pin to TSBAT_SYNCOUT of master.      |

| Pin No.                | Pin Name                | I/O | Pin Function  |
|------------------------|-------------------------|-----|---|
| B5, C5, D5, E5, F5, G5 | PMID                    | P   | Connected to the drain of the reverse blocking NFET. One 10 $\mu$ F capacitors must be connected to PMID and PGND.  |
| B6                     | SRN                     | AI  | Negative input for battery current sensing. Place 5m $\Omega$ or 2m $\Omega$ between SRN and SRP.   |
| B7                     | BATN                    | AI  | Negative input for battery voltage sensing. Connect 100 $\Omega$ in series with negative terminal of battery pack.  |
| C6, D6, E6, F6         | VBUS                    | P   | These pins are the input power supply and must be connected together on the PCB. One 1 $\mu$ F capacitor must be connected to VBUS and GND.   |
| C7                     | $\overline{\text{INT}}$ | DO  | Open drain interrupt output. Connect to pull-up voltage via 10k $\Omega$ pull-up resistor. Normally high, when event happen, INT pin sends a 256 $\mu$ s low pulse to system.   |
| D7                     | OVPGATE                 | AO  | External N-FET control pin, connect to gate of external N-FET.  |
| E4, F4, G4, H4         | CFH1                    | P   | Flying capacitor positive node. Three 22 $\mu$ F capacitors must be connected to CFL1 and CFH1 and placed as close as possible to the device. These pins must be connected together on the PCB.   |
| E7                     | VAC                     | AI  | Input voltage sense pin, connect to drain of external N-FET   |
| F7                     | SCL                     | DI  | I <sup>2</sup> C serial clock line. Connect to pull-up voltage via 10k $\Omega$ pull-up resistor.   |
| G6                     | AVDD                    | AO  | Analog power supply. This pin is the internal power supply. It is recommended to connect a 4.7 $\mu$ F capacitor from AVDD to the GND plane, and placed as close as possible to the device. Do not use this pin for other function.         |
| G7                     | SDA                     | DIO | I <sup>2</sup> C serial data line. Connect to pull-up voltage via 10k $\Omega$ pull-up resistor.  |
| H5                     | TSBUS                   | AI  | BUS temperature qualification voltage input. Requires external resistor divider and voltage reference.  |
| H6                     | CDRVH                   | AIO | Charge pump for gate drive. Connect a 0.22 $\mu$ F capacitor between CDRVH and CDRVL_ADDRMS.  |
| H7                     | CDRVL_ADDRMS            | AIO | Charge pump for gate drive. Connect a 0.22 $\mu$ F capacitor between CDRVH and CDRVL_ADDRMS. Place different resistance between CDRVL_ADDRMS and GND to assign the address of device and the mode of device as Standalone, Master or Slave. |

## Typical Application Circuit

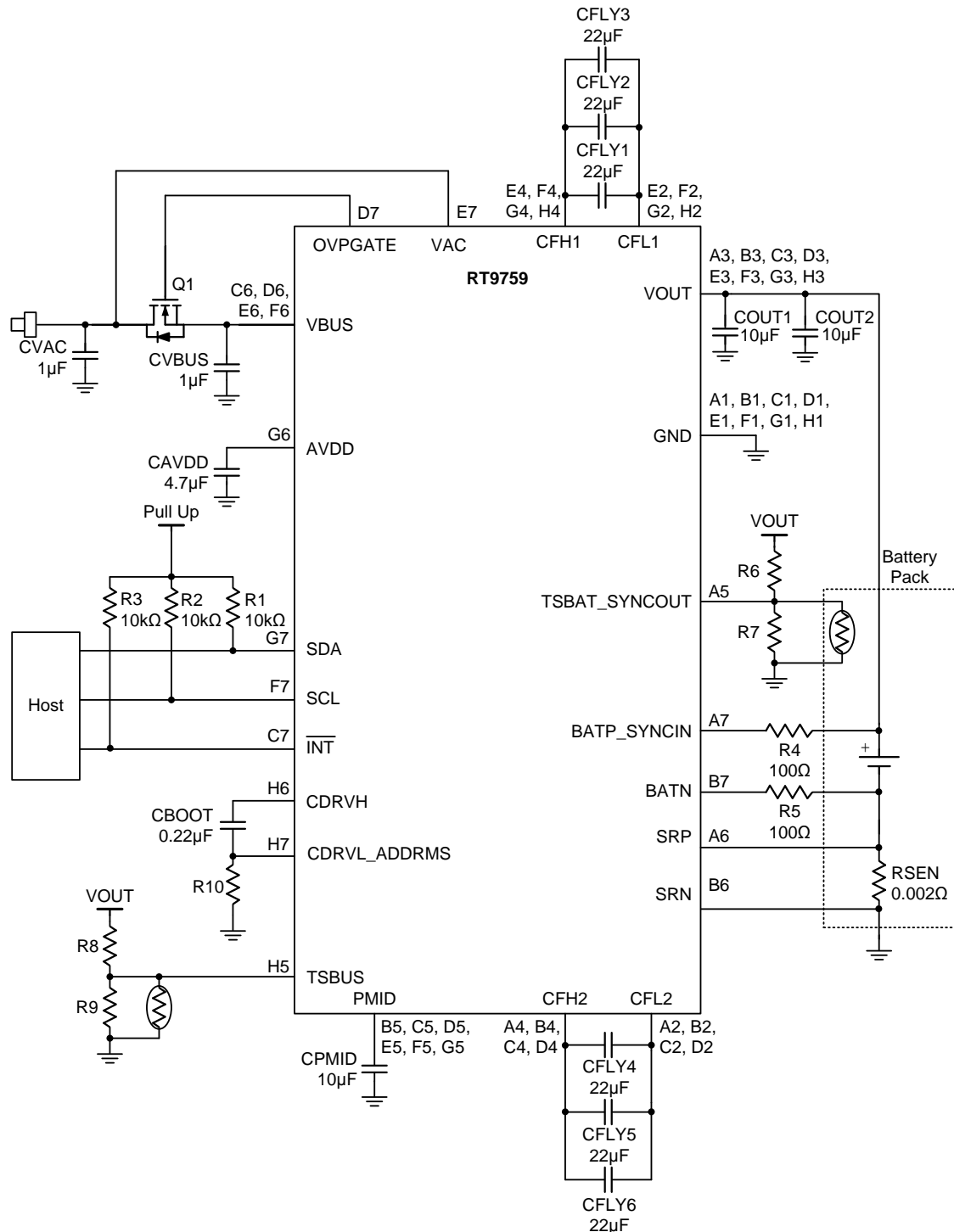
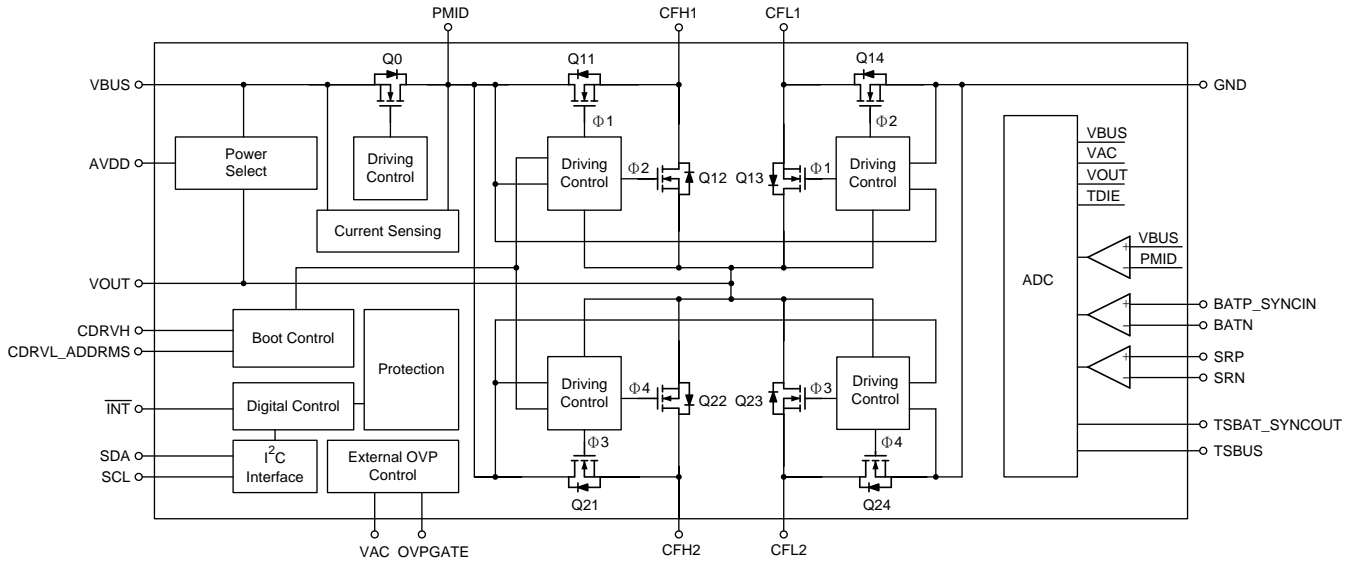


Table 1. BOM List

| Name  | Part Number        | Description                    | Package | Manufacturer |
|-------|--------------------|--------------------------------|---------|--------------|
| CVAC  | GRM188R61H105KAAL  | CAP, CERM, 1µF, 50V, ±10%, X5R | 0603    | MuRata       |
| CVBUS | GRM188R61E105KA12D | CAP, CERM, 1µF, 25V, ±10%, X5R | 0603    | MuRata       |

| Name                                     | Part Number        | Description  | Package | Manufacturer              |
|--|--------------------|--|---------|---------------------------|
| Q1                                       | PSMN2R4-30MLD      | N-Channel 30V, 2.4mΩ logic level MOSFET in LFPAK33, using NextPowerS3 Technology | LFPAK33 | Nexperia                  |
| CFLY1, CFLY2, CFLY3, CFLY4, CFLY5, CFLY6 | GRM188R61A226ME15D | CAP, CERM, 22μF, 10V, ±20%, X5R  | 0603    | MuRata                    |
| COU1, COU2                               | GRM185R60J106ME15  | CAP, CERM, 10μF, 6.3V, ±20%, X5R   | 0603    | MuRata                    |
| CPMID                                    | GRM188R61E106MA73  | CAP, CERM, 10μF, 25V, ±20%, X5R  | 0603    | MuRata                    |
| CBOOT                                    | GRM033R61C224KE14  | CAP, CERM, 0.22μF, 16V, ±10%, X5R  | 0201    | MuRata                    |
| CAVDD                                    | GRM155R61A475MEAAD | CAP, CERM, 4.7μF, 10V, ±20%, X5R   | 0402    | MuRata                    |
| R1, R2, R3                               | CRCW040210K0JNED   | RES, 10k, 5%, 0.063W   | 0402    | Vishay-Dale               |
| R4, R5                                   | ERJ-2RKF1000X      | RES, 100Ω, 1%, 0.1W, 0402  | 0402    | Panasonic                 |
| RSEN                                     | CSNL1206FT2L00     | RES, 0.002, 1%, 1W   | 1206    | Stackpole Electronics Inc |

**Functional Block Diagram**



## Absolute Maximum Ratings (Note 1)

|  |       |                |
|--|-------|----------------|
| • Supply Pin Voltage, VAC  | ----- | -2V to 40V     |
| • Supply Pin Voltage, VBUS   | ----- | -2V to 22V     |
| • Supply Pin Voltage, VOUT   | ----- | -0.7V to 6V    |
| • Control Pin Voltage, OVPGATE   | ----- | -0.3V to 40V   |
| • Terminal Pin Voltage, PMID   | ----- | -0.3V to 22V   |
| • Terminal Pin Voltage, CDRVH  | ----- | -0.3V to 18V   |
| • Terminal Pin Voltage, CFH1, CFH2   | ----- | -0.3V to 12V   |
| • Terminal Pin Voltage, CFL1, CFL2   | ----- | -0.3V to 6V    |
| • Terminal Pin Voltage, $\overline{\text{INT}}$ , SDA, SCL, CDRVL_ADDRMS, AVDD | ----- | -0.3V to 6V    |
| • Terminal Pin Voltage, SRP, SRN   | ----- | -0.3V to 6V    |
| • Terminal Pin Voltage, B ATP_SYNCIN, BATN                                     | ----- | -0.3V to 6V    |
| • Terminal Pin Voltage, TSBUS, TSBAT_SYNCOUT                                   | ----- | -0.3V to 6V    |
| • Terminal Pin Current, $\overline{\text{INT}}$                                | ----- | 0mA to 6mA     |
| • Power Dissipation, P <sub>D</sub> @ T <sub>A</sub> = 25°C                    |       |                |
| WL-CSP-56B 3.35x3.35 (BSC)   | ----- | 4.16W          |
| • Package Thermal Resistance (Note 2)  |       |                |
| WL-CSP-56B 3.35x3.35 (BSC), $\theta_{JA}$                                      | ----- | 24°C/W         |
| • Lead Temperature (Soldering, 10 sec.)  | ----- | 260°C          |
| • Junction Temperature   | ----- | -40°C to 150°C |
| • Storage Temperature Range  | ----- | -65°C to 150°C |
| • ESD Susceptibility (Note 3)  |       |                |
| HBM (Human Body Model), per ANSI/ESDA/JEDEC JS-001                             | ----- | ±2kV           |
| CDM (Charged Device Model), per JEDEC specification JESD22-C101                | ----- | ±500V          |

## Recommended Operating Conditions (Note 4)

|  |       |                |
|--|-------|----------------|
| • Supply Pin Voltage, VAC                                      | ----- | 2.8V to 17V    |
| • Supply Input Voltage Range, VBUS, PMID                       | ----- | 2.8V to 11V    |
| • Output Voltage Range, VOUT                                   | ----- | 2.8V to 5V     |
| • Analog Sense Voltage Range, B ATP_SYNCIN, BATN               | ----- | 0V to 5V       |
| • Analog Sense Voltage Range, SRP, SRN                         | ----- | 0V to 0.2V     |
| • Temperature Sense Voltage Range, TSBUS, TSBAT_SYNCOUT        | ----- | 0V to 2.25V    |
| • Positive flying capacitor Voltage Range, CFH1, CFH2          | ----- | 0V to 11V      |
| • Negative flying capacitor Voltage Range, CFL1, CFL2          | ----- | 0V to 5V       |
| • I/O Control Voltage Range, SDA, SCL, $\overline{\text{INT}}$ | ----- | 0V to 5V       |
| • Charger Current Range, IBAT                                  | ----- | 0A to 8A       |
| • Ambient Temperature Range                                    | ----- | -40°C to 85°C  |
| • Junction Temperature Range                                   | ----- | -40°C to 150°C |

**Electrical Characteristics**

(T<sub>A</sub> = 25°C, unless otherwise specified)

| Parameter   | Symbol                         | Test Conditions   | Min  | Typ | Max   | Unit |
|---|--------------------------------|---|------|-----|-------|------|
| <b>External OVP Control</b>                           |                                |   |      |     |       |      |
| OVPGATE Voltage                                       | V <sub>OVPGATE</sub>           | Operation voltage OVPGATE – V <sub>BUS</sub> , V <sub>AC</sub> = 6V to 9V   | 9    | 10  | 11    | V    |
| V <sub>AC</sub> _INSERT Threshold                     | V <sub>AC_INSERT_TH</sub>      | V <sub>AC</sub> rising threshold to turn on external MOS  | 2.6  | 2.8 | 3     | V    |
| V <sub>AC</sub> _INSERT Hysteresis                    | V <sub>AC_INSERT_HY</sub>      | V <sub>AC</sub> falling hysteresis to turn off external MOS   | 250  | 500 | 750   | mV   |
| V <sub>AC</sub> _INSERT Deglitch Time                 | t <sub>VAC_INSERT_DEG</sub>    | Deglitch time between V <sub>AC</sub> higher than V <sub>AC_INSERT_TH</sub> and turn on external MOS                                  | 18   | 20  | 22    | ms   |
| V <sub>AC</sub> Insert Threshold Rising Deglitch Time | V <sub>AC_INSERT_RIS_DEG</sub> | Deglitch between V <sub>AC</sub> over V <sub>AC_INSERT_TH</sub> and sent an INT.  | --   | 1   | --    | ms   |
| V <sub>AC</sub> OVP Range                             | V <sub>AC_OVP_RAN</sub>        | I <sup>2</sup> C programmable, 3-bit DAC, 6.5V, 11V to 17V  | 6.5  | --  | 17    | V    |
| V <sub>AC</sub> OVP Accuracy                          | V <sub>AC_OVP_ACC</sub>        | V <sub>AC_OVP</sub> Threshold accuracy  | -2   | --  | 2     | %    |
| V <sub>AC</sub> OVP Hysteresis                        | V <sub>AC_OVP_HY</sub>         | V <sub>AC</sub> falling to turn on external MOS after V <sub>AC</sub> OVP happen  | 250  | 500 | 750   | mV   |
| OVPGATE Turn-Off Time                                 | t <sub>VAC_OVP_OFF</sub>       | Duration between OVPGATE start to turn off external MOS and the external MOS be fully turn off, C <sub>GS</sub> = 4nF                 | --   | 100 | --    | ns   |
| OVPGATE Reaction Time                                 | t <sub>VAC_OVP_RE</sub>        | Duration between V <sub>AC</sub> over V <sub>AC_OVP</sub> threshold and OVPGATE start to turn off external MOS, C <sub>GS</sub> = 4nF | --   | 100 | --    | ns   |
| V <sub>BAT</sub> Regulation Range                     | V <sub>BAT_REG_RAN</sub>       | V <sub>BAT_OVP</sub> – Register 0x2C[5:4] setting   | 3.5  | --  | 5.075 | V    |
| V <sub>BAT</sub> Regulation Accuracy                  | V <sub>BAT_REG_ACC</sub>       | V <sub>BAT</sub> = 4.2V to 4.65V  | -20  | --  | 20    | mV   |
| I <sub>BAT</sub> Regulation Range                     | I <sub>BAT_REG_RAN</sub>       | I <sub>BAT_OCP</sub> – Register 0x2C[7:6] setting   | 2    | --  | 10    | A    |
| I <sub>BAT</sub> Regulation Accuracy                  | I <sub>BAT_REG_ACC</sub>       | I <sub>BAT</sub> = 2A to 5A, R <sub>SEN</sub> = 0.002Ω  | -200 | --  | 200   | mA   |
| Regulation Time Out                                   | t <sub>REG_TIMEOUT</sub>       | If device in regulation and no V <sub>DROVP</sub> for this time, the device will stop charge.   | 585  | 650 | 715   | ms   |

| Parameter                                  | Symbol                          | Test Conditions   | Min  | Typ | Max  | Unit |
|--|---------------------------------|---|------|-----|------|------|
| <b>Power Select and Source</b>             |                                 |   |      |     |      |      |
| VBUS Quiescent Current                     | I <sub>BUS_IQ</sub>             | ADC disable, charge disable, OVP MOS no used, VBUS and VAC are open. VOUT no present. Measure quiescent current on VBUS.            | --   | 55  | 95   | μA   |
| VAC Quiescent Current                      | I <sub>AC_IQ</sub>              | ADC disable, charge disable, OVP MOS used, VOUT no present, no VAC_OVP happen. Measure quiescent current on VAC. VAC = 3.5V to 12V. | --   | 315 | 395  | μA   |
|  |                                 | ADC enable, charge disable, OVP MOS used, VOUT no present. Measure quiescent current on VAC.  | --   | 3   | 4    | mA   |
| VOUT Quiescent Current                     | I <sub>OUT_IQ</sub>             | ADC disable, charge disable, VAC no present. VOUT falling from 4.5V to 0V, Measure quiescent current on VOUT.                       | --   | 10  | 16   | μA   |
|  |                                 | ADC enable, charge disable, VAC no present. Measure quiescent current on VOUT.  | --   | 2   | 3    | mA   |
| VDDA UVLO Threshold                        | V <sub>DDA_UVLO_TH</sub>        | V <sub>DDA</sub> rising   | 2.6  | 2.8 | 3    | V    |
| VDDA UVLO Hysteresis                       | V <sub>DDA_UVLO_HY</sub>        | V <sub>DDA</sub> falling  | --   | 0.8 | --   | V    |
| Device Start Up Time                       | t <sub>VDDA_START</sub>         | Duration time between VDDA > V <sub>DDA_UVLO_TH</sub> and device can start I <sup>2</sup> C communicate                             | --   | --  | 64   | ms   |
| Soft-Start Time                            | t <sub>SOFT_START</sub>         | Duration time between the device start switching and CHG_EN = 1   | --   | --  | 50   | ms   |
| VOUT Insert Threshold                      | V <sub>OUT_INSERT_TH</sub>      | VOUT rising   | 2.65 | 2.8 | 2.95 | V    |
| VOUT Insert Threshold Rising Deglitch Time | V <sub>OUT_INSERT_RIS_DEG</sub> |   | --   | 17  | --   | μs   |
| VOUT Insert Hysteresis                     | V <sub>OUT_INSERT_HY</sub>      | VOUT falling  | 50   | 150 | 250  | mV   |
| <b>Cap Divider Charger</b>                 |                                 |   |      |     |      |      |
| Q0 RON                                     | R <sub>Q0</sub>                 | VBUS = 9V, VOUT = 4.5V charge enable  | --   | 6   | 8    | mΩ   |
| Q11, Q21 RON                               | R <sub>Q11, RQ21</sub>          | VBUS = 9V, VOUT = 4.5V, charge enable   | --   | 14  | 19   | mΩ   |
| Q12, Q22 RON                               | R <sub>Q12, RQ22</sub>          | VBUS = 9V, VOUT = 4.5V charge enable  | --   | 9.5 | 13   | mΩ   |
| Q13, Q23 RON                               | R <sub>Q13, RQ23</sub>          | VBUS = 9V, VOUT = 4.5V charge enable  | --   | 8   | 12.5 | mΩ   |
| Q14, Q24 RON                               | R <sub>Q14, RQ24</sub>          | VBUS = 9V, VOUT = 4.5V Charge enable  | --   | 9   | 12.5 | mΩ   |



| Parameter                   | Symbol                         | Test Conditions   | Min  | Typ | Max   | Unit |
|-----------------------------|--------------------------------|---|------|-----|-------|------|
| Charge Switch Frequency     | fsw                            | Select by register 0x0B[6:5] = 11                           | 675  | 750 | 825   | kHz  |
|                             |                                | Select by register 0x0B[6:5] = 10, default                  | 450  | 500 | 550   |      |
|                             |                                | Select by register 0x0B[6:5] = 01                           | 337  | 375 | 412   |      |
|                             |                                | Select by register 0x0B[6:5] = 00                           | 225  | 250 | 275   |      |
| <b>Protection</b>           |                                |   |      |     |       |      |
| VBAT OVP Range              | V <sub>BAT_OVP_RAN</sub>       | Rising  | 3.5  | --  | 5.075 | V    |
| VBAT OVP Step Size          | V <sub>BAT_OVP_SIZE</sub>      |   | --   | 25  | --    | mV   |
| VBAT OVP Accuracy           | V <sub>BAT_OVP_ACC</sub>       | V <sub>BAT_OVP</sub> = 4.2V to 4.65V                        | -20  | --  | 20    | mV   |
| VBAT OVP Deglitch time      | t <sub>VBAT_OVP_DEG</sub>      |   | --   | 3   | --    | μs   |
| IBAT_OCP Range              | I <sub>BAT_OCP_RAN</sub>       | Rising  | 2    | --  | 10    | A    |
| IBAT_OCP Step Size          | I <sub>BAT_OCP_SIZE</sub>      |   | --   | 100 | --    | mA   |
| IBAT_OCP Accuracy           | I <sub>BAT_OCP_ACC</sub>       | IBAT_OCP = 3A to 8A,<br>RSEN = 0.002Ω                       | -200 | --  | 200   | mA   |
| IBAT OCP Deglitch time      | t <sub>IBAT_OCP_DEG</sub>      |   | --   | 50  | --    | μs   |
| VBUS OVP Range              | V <sub>BUS_OVP_RAN</sub>       | Rising  | 6    | --  | 12.35 | V    |
| VBUS OVP Step Size          | V <sub>BUS_OVP_SIZE</sub>      |   | --   | 50  | --    | mV   |
| VBUS OVP Accuracy           | V <sub>BUS_OVP_ACC</sub>       |   | -35  | --  | 35    | mV   |
| VBUS OVP Deglitch Time      | t <sub>VBUS_OVP_DEG</sub>      |   | --   | 3   | --    | μs   |
| IBUS_OCP Range              | I <sub>BUS_OCP_RAN</sub>       | Rising  | 1    | --  | 4.75  | A    |
| IBUS_OCP Step Size          | I <sub>BUS_OCP_SIZE</sub>      |   | --   | 250 | --    | mA   |
| IBUS_OCP Accuracy           | I <sub>BUS_OCP_ACC</sub>       |   | -250 | --  | 250   | mA   |
| IBUS_OCP Deglitch           | t <sub>IBUS_OCP_DEG</sub>      |   | --   | 50  | --    | μs   |
| IBUS_UCP_RISE Accuracy      | I <sub>BUS_UCP_RISE_ACC</sub>  | Rising, IBUS_UCP_RISE = 300mA, set by Register 0x2B[2] = 0  | 200  | 300 | 400   | mA   |
|                             | I <sub>BUS_UCP_RISE_ACC</sub>  | Rising, IBUS_UCP_RISE = 500mA, set by Register 0x2B[2] = 1  | 400  | 500 | 600   | mA   |
| IBUS_UCP_RISE Deglitch Time | t <sub>IBUS_UCP_RISE_DEG</sub> |   | --   | 22  | --    | μs   |
| IBUS_UCP_FALL Accuracy      | I <sub>BUS_UCP_FALL_ACC</sub>  | Falling, IBUS_UCP_FALL = 150mA, set by Register 0x2B[2] = 0 | 10   | 150 | 290   | mA   |
|                             | I <sub>BUS_UCP_FALL_ACC</sub>  | Falling, IBUS_UCP_FALL = 250mA, set by Register 0x2B[2] = 1 | 110  | 250 | 390   |      |

| Parameter                      | Symbol                         | Test Conditions  | Min   | Typ    | Max   | Unit |
|--------------------------------|--------------------------------|--|-------|--------|-------|------|
| IBUS_UCP_FALL<br>Deglitch Time | t <sub>IBUS_UCP_FALL_DEG</sub> | t <sub>IBUS_UCP_FALL_DEG</sub> = 10μs,<br>set by Register 0x2E[3] = 0      | --    | 22     | --    | μs   |
|                                |                                | t <sub>IBUS_UCP_FALL_DEG</sub> = 5ms,<br>set by Register 0x2E[3] = 1       | --    | 5      | --    | ms   |
| IBUS UCP Time Out              | t <sub>IBUS_UCP_TIMEOUT</sub>  | t <sub>IBUS_UCP_TIMEOUT</sub> = 12.5ms,<br>set by Register 0x2B[7:5] = 001 | 11.25 | 12.5   | 13.75 | ms   |
|                                |                                | t <sub>IBUS_UCP_TIMEOUT</sub> = 25ms,<br>set by Register 0x2B[7:5] = 010   | 22.5  | 25     | 27.5  | ms   |
|                                |                                | t <sub>IBUS_UCP_TIMEOUT</sub> = 50ms,<br>set by Register 0x2B[7:5] = 011   | 45    | 50     | 55    | ms   |
|                                |                                | t <sub>IBUS_UCP_TIMEOUT</sub> = 100ms,<br>set by Register 0x2B[7:5] = 100  | 90    | 100    | 110   | ms   |
|                                |                                | t <sub>IBUS_UCP_TIMEOUT</sub> = 400ms,<br>set by Register 0x2B[7:5] = 101  | 360   | 400    | 440   | ms   |
|                                |                                | t <sub>IBUS_UCP_TIMEOUT</sub> = 1.5s, set<br>by Register 0x2B[7:5] = 110   | 1.35  | 1.5    | 1.65  | sec  |
|                                |                                | t <sub>IBUS_UCP_TIMEOUT</sub> = 100s, set<br>by Register 0x2B[7:5] = 111   | 90    | 100    | 110   | sec  |
| VDR OVP Accuracy               | V <sub>DR_OVP_ACC</sub>        | Rising, VDR_OVP = 300mV,<br>set by Register 0x05[4] = 0                    | 245   | 300    | 355   | mV   |
|                                |                                | Rising, VDR_OVP = 400mV,<br>set by Register 0x05[4] = 1                    | 345   | 400    | 455   |      |
| VDR OVP Deglitch time          | t <sub>VDR_OVP_DEG</sub>       | VDR OVP Deglitch = 8μs, set<br>by Register 0x05[3] = 0                     | --    | 8      | --    | μs   |
|                                |                                | VDR OVP Deglitch = 10ms,<br>set by Register 0x05[3] = 1                    | --    | 5      | --    | ms   |
| VOUT OVP Accuracy              | V <sub>OUT_OVP_ACC</sub>       | Rising, VOUT_OVP = 4.9V  | 4.8   | 4.9    | 5     | V    |
| VOUT OVP Deglitch Time         | t <sub>VOUT_OVP_DEG</sub>      |  | --    | 3      | --    | μs   |
| TSBAT OTP Range                | T <sub>SBAT_OTP_RAN</sub>      | Falling, TSBAT_OTP =<br>TSBAT/VOUT, (VOUT < 4.6V)                          | 0     | --     | 50    | %    |
| TSBAT OTP Step Size            | T <sub>SBAT_OTP_SIZE</sub>     | Falling, TSBAT_OTP =<br>TSBAT/VOUT, (VOUT < 4.6V)                          | --    | 0.1953 | --    | %    |
| TSBAT OTP Accuracy             | T <sub>SBAT_OTP_ACC</sub>      | Falling, TSBAT_OTP =<br>TSBAT/VOUT, (VOUT < 4.6V)                          | -1    | --     | 1     | %    |
| TSBUS OTP Range                | T <sub>SBUS_OTP_RAN</sub>      | Falling, TSBUS_OTP =<br>TSBUS /VOUT, (VOUT <<br>4.6V)                      | 0     | --     | 50    | %    |
| TSBUS OTP Step Size            | T <sub>SBUS_OTP_SIZE</sub>     | Falling, TSBUS_OTP =<br>TSBUS /VOUT, (VOUT <<br>4.6V)                      | --    | 0.1953 | --    | %    |

| Parameter                      | Symbol                         | Test Conditions   | Min   | Typ  | Max   | Unit |
|--------------------------------|--------------------------------|---|-------|------|-------|------|
| TSBUS OTP Accuracy             | T <sub>TSBUS_OTP_ACC</sub>     | Falling, TSBUS_OTP = TSBUS /VOUT, (VOUT < 4.6V)   | -1    | --   | 1     | %    |
| Thermal Shutdown Threshold     | T <sub>DIE_OTP_TH</sub>        |   | --    | 130  | --    | °C   |
| Thermal Shutdown Deglitch Time | t <sub>DIE_DEG</sub>           |   | --    | 3    | --    | μs   |
| VBUS_HIGH_ERR Accuracy         | V <sub>BUS_HIGH_ERR_ACC</sub>  | Rising, VBUS_HIGH_ERR = VBUS/VOUT   | 2.328 | 2.4  | 2.472 | V/V  |
| VBUS_HIGH_ERR Deglitch         | t <sub>VBUS_HIGH_ERR_DEG</sub> |   | --    | 32   | --    | μs   |
| VBUS_LOW_ERR Accuracy          | V <sub>BUS_LOW_ERR_ACC</sub>   | Falling, VBUS_LOW_ERR = VBUS/VOUT   | 2     | 2.04 | 2.08  | V/V  |
| VBUS_LOW_ERR Deglitch          | t <sub>VBUS_LOW_ERR_DEG</sub>  | Set by Register 0x2E[4] = 0   | --    | 10   | --    | μs   |
|                                |                                | Set by Register 0x2E[4] = 1   | --    | 10   | --    | ms   |
| Converter OCP Threshold        | I <sub>CON_OCP_TH</sub>        | Rising, VOUT = 4V   | --    | 16   | --    | A    |
| CFLY Short Detect Level        | R <sub>CFLY_DIAG</sub>         | If device detect the short resistance of flying capacitor smaller than this level while soft-start duration, the device will stop charging. | --    | --   | 30    | Ω    |
| <b>Alarm</b>                   |                                |   |       |      |       |      |
| VBAT_OVP_ALM Range             | V <sub>BAT_OVP_ALM_RAN</sub>   | Rising  | 3.5   | --   | 5.075 | V    |
| VBAT_OVP_ALM Step Size         | V <sub>BAT_OVP_ALM_SIZE</sub>  |   | --    | 25   | --    | mV   |
| VBAT_OVP_ALM Hysteresis        | V <sub>BAT_OVP_ALM_HY</sub>    | Falling   | --    | 50   | --    | mV   |
| VBAT_OVP_ALM Accuracy          | V <sub>BAT_OVP_ALM_ACC</sub>   | VBAT_OVP_ALM = 3.5V to 4.5V   | -20   | --   | 20    | mV   |
| IBAT_OCP_ALM Range             | I <sub>BAT_OCP_ALM_RAN</sub>   | Rising  | 2     | --   | 10    | A    |
| IBAT_OCP_ALM Step Size         | I <sub>BAT_OCP_ALM_SIZE</sub>  |   | --    | 100  | --    | mA   |
| IBAT_OCP_ALM Hysteresis        | I <sub>BAT_OCP_ALM_HY</sub>    | Falling   | --    | 100  | --    | mA   |
| IBAT_OCP_ALM Accuracy          | I <sub>BAT_OCP_ALM_ACC</sub>   | IBAT_OCP_ALM = 3A to 8A   | -200  | --   | 200   | mA   |
| IBAT_UCP_ALM Range             | I <sub>BAT_UCP_ALM_RAN</sub>   | Falling   | 0     | --   | 6.35  | A    |
| IBAT_UCP_ALM Step Size         | I <sub>BAT_UCP_ALM_SIZE</sub>  |   | --    | 50   | --    | mA   |
| IBAT_UCP_ALM Hysteresis        | I <sub>BAT_UCP_ALM_HY</sub>    | Falling   | --    | 50   | --    | mA   |
| IBAT_UCP_ALM Accuracy          | I <sub>BAT_UCP_ALM_ACC</sub>   | IBAT_UCP_ALM = 3A   | -200  | --   | 200   | mA   |
| VBUS_OVP_ALM Range             | V <sub>BUS_OVP_ALM_RAN</sub>   | Rising  | 6     | --   | 12.35 | V    |

| Parameter                  | Symbol                        | Test Conditions   | Min  | Typ  | Max   | Unit |
|----------------------------|-------------------------------|---|------|------|-------|------|
| VBUS_OVP_ALM Step Size     | V <sub>BUS_OVP_ALM_SIZE</sub> |   | --   | 50   | --    | mV   |
| VBUS_OVP_ALM Hysteresis    | V <sub>BUS_OVP_ALM_HY</sub>   | Falling   | --   | 50   | --    | mV   |
| VBUS_OVP_ALM Accuracy      | V <sub>BUS_OVP_ALM_ACC</sub>  | V <sub>BAT_OVP_ALM</sub> = 6V to 9V   | -35  | --   | 35    | mV   |
| IBUS_OCP_ALM Range         | I <sub>BUS_OCP_ALM_RAN</sub>  | Rising  | 0    | --   | 5     | A    |
| IBUS_OCP_ALM Step Size     | I <sub>BUS_OCP_ALM_SIZE</sub> |   | --   | 50   | --    | mA   |
| IBUS_OCP_ALM Hysteresis    | I <sub>BUS_OCP_ALM_HY</sub>   | Falling   | --   | 50   | --    | mA   |
| IBUS_OCP_ALM Accuracy      | I <sub>BUS_OCP_ALM_ACC</sub>  | I <sub>BUS_OCP</sub> = 1.5A to 4A   | -250 | --   | 250   | mA   |
| TSBAT_TSBUS_ALM Range      | T <sub>S_OTP_ALM_RAN</sub>    | Falling,<br>TSBAT_TSBUS_ALM_Thresh<br>old = TSBAT_OTP + 5% or<br>TSBAT_TSBUS_ALM_Thresh<br>old = TSBUS_OTP + 5% | 0    | --   | 50    | %    |
| TSBAT_TSBUS_ALM Hysteresis | T <sub>S_OTP_ALM_ALM_HY</sub> | Rising  | --   | 4    | --    | %    |
| TSBAT_TSBUS_ALM Accuracy   | T <sub>S_OTP_ALM_ACC</sub>    |   | -1   | --   | 1     | %    |
| TDIE_OTP_ALM Range         | T <sub>DIE_OTP_ALM_RAN</sub>  | Rising  | 0    | --   | 152.5 | °C   |
| TDIE_OTP_ALM Step Size     | T <sub>DIE_OTP_ALM_SIZE</sub> |   | --   | 0.5  | --    | °C   |
| TDIE_OTP_ALM Hysteresis    | T <sub>DIE_OTP_ALM_HY</sub>   | Falling   | --   | 10   | --    | °C   |
| TDIE_OTP_ALM Accuracy      | T <sub>DIE_OTP_ALM_ACC</sub>  |   | -4   | --   | 4     | °C   |
| <b>ADC Specification</b>   |                               |   |      |      |       |      |
| ADC Sample Rate            | f <sub>SAMPLE_RATE</sub>      | (Note 5)  | 1800 | 2000 | 2200  | kHz  |
| ADC Data Rate              | t <sub>DATA_ADC</sub>         | 12bit, 128 averages<br>Report data for each channel<br>(Note 5)   | --   | 1.2  | --    | ms   |
| VBUS ADC Range             | V <sub>BUS_ADC_RAN</sub>      |   | 0    | --   | 14    | V    |
| VBUS ADC Accuracy          | V <sub>BUS_ADC_ACC</sub>      | V <sub>BUS</sub> = 6V to 9V   | -35  | --   | 35    | mV   |
| IBUS ADC Range             | I <sub>BUS_ADC_RAN</sub>      |   | 0    | --   | 5     | A    |
| IBUS ADC Accuracy          | I <sub>BUS_ADC_ACC</sub>      | I <sub>BUS</sub> = 0A to 4A (0°C to 85°C)   | -150 | --   | 150   | mA   |
| VAC ADC Range              | V <sub>AC_ADC_RAN</sub>       |   | 0    | --   | 14    | V    |
| VAC ADC Accuracy           | V <sub>AC_ADC_ACC</sub>       | V <sub>AC</sub> = 6V to 9V  | -35  | --   | 35    | mV   |
| VOOUT ADC Range            | V <sub>OUT_ADC_RAN</sub>      |   | 0    | --   | 5     | V    |
| VOOUT ADC Accuracy         | V <sub>OUT_ADC_ACC</sub>      | V <sub>OUT</sub> = 3V to 4.5V   | -20  | --   | 20    | mV   |
| VBAT ADC Range             | V <sub>BAT_ADC_RAN</sub>      |   | 0    | --   | 5     | V    |

| Parameter                                | Symbol                    | Test Conditions  | Min   | Typ | Max   | Unit |
|--|---------------------------|--|-------|-----|-------|------|
| VBAT ADC Accuracy                        | V <sub>BAT_ADC_ACC</sub>  | VBAT = 3V to 4.5V  | -20   | --  | 20    | mV   |
| IBAT ADC Range                           | I <sub>BAT_ADC_RAN</sub>  |  | 0     | --  | 10    | A    |
| IBAT ADC Accuracy                        | I <sub>BAT_ADC_ACC</sub>  | IBAT = 3A to 8A,<br>RSEN = 0.002Ω  | -200  | --  | 200   | mA   |
| TDIE ADC Range                           | T <sub>DIE_ADC_RAN</sub>  |  | 0     | --  | 150   | °C   |
| TDIE ADC Accuracy                        | T <sub>DIE_ADC_ACC</sub>  |  | -4    | --  | 4     | °C   |
| TSBUS ADC Range                          | T <sub>SBUS_ADC_RAN</sub> |  | 0     | --  | 50    | %    |
| TSBUS ADC Accuracy                       | T <sub>SBUS_ADC_ACC</sub> | TSBUS pin voltage = 0.2V to 2V   | -1    | --  | 1     | %    |
| TSBAT ADC Range                          | T <sub>SBAT_ADC_RAN</sub> |  | 0     | --  | 50    | %    |
| TSBAT ADC Accuracy                       | T <sub>BAT_ADC_ACC</sub>  | TSBAT pin voltage = 0.2V to 2V   | -1    | --  | 1     | %    |
| <b>Pull Down</b>                         |                           |  |       |     |       |      |
| VAC Pull Down Resistor                   | R <sub>VAC_PD</sub>       |  | 100   | 125 | 150   | Ω    |
| VAC Pull Down Time Out                   | t <sub>VAC_PD</sub>       |  | 360   | 400 | 440   | ms   |
| VBUS Pull Down Resistor                  | R <sub>VBUS_PD</sub>      |  | 0.6   | 1   | 1.4   | kΩ   |
| <b>Watch Dog Time Out</b>                |                           |  |       |     |       |      |
| Watch Dog Time Out                       | WDT                       | No I <sup>2</sup> C communication for 0.5s, set by Register 0x0b[1:0] = 00 | 0.475 | 0.5 | 0.525 | sec  |
|  |                           | No I <sup>2</sup> C communication for 1s, set by Register 0x0b[1:0] = 01   | 0.95  | 1   | 1.05  |      |
|  |                           | No I <sup>2</sup> C communication for 5s, set by Register 0x0b[1:0] = 10   | 4.75  | 5   | 5.25  |      |
|  |                           | No I <sup>2</sup> C communication for 30s, set by Register 0x0b[1:0] = 11  | 27    | 30  | 33    |      |
| <b>CDRVL Pull Low Resistance Setting</b> |                           |  |       |     |       |      |
| Slave address = 0x66 (Standalone1)       | R <sub>CDRVL</sub>        | CDRVL Pull low resistance to setting slave address                         | 142.5 | 150 | --    | kΩ   |
| Slave address = 0x65 (Standalone2)       |                           |  | 71.25 | 75  | 78.75 |      |
| Slave address = 0x66 (Slave)             |                           |  | 37.05 | 39  | 40.95 |      |
| Slave address = 0x65 (Master)            |                           |  | --    | 18  | 18.9  |      |

I<sup>2</sup>C Characteristics

| Parameter                                      | Symbol              | Test Conditions                         | Min  | Typ | Max  | Unit |
|--|---------------------|---|------|-----|------|------|
| SCL, SDA High-Level Input Threshold Voltage    | V <sub>IH_I2C</sub> |   | 1.5  | --  | --   | V    |
| SCL, SDA Low-Level Input Threshold Voltage     | V <sub>IL_I2C</sub> |   | --   | --  | 0.4  | V    |
| SCL Clock Frequency                            | f <sub>CLK</sub>    | Standard-mode                           | --   | --  | 100  | kHz  |
|  |                     | Fast-mode                               | --   | --  | 400  |      |
|  |                     | Fast-mode Plus                          | --   | --  | 1000 |      |
|  |                     | High-speed mode C <sub>b</sub> = 400pF  | --   | --  | 1.7  | MHz  |
|  |                     | High-speed mode C <sub>b</sub> = 100pF  | --   | --  | 3.4  |      |
| Bus Free Time between Stop and Start Condition | t <sub>BUF</sub>    | Standard-mode                           | 4.7  | --  | --   | μs   |
|  |                     | Fast-mode                               | 1.3  | --  | --   |      |
|  |                     | Fast-mode Plus                          | 0.5  | --  | --   |      |
| (Repeated) Start Hold Time                     | t <sub>HD;STA</sub> | Standard-mode                           | 4    | --  | --   | μs   |
|  |                     | Fast-mode                               | 0.6  | --  | --   |      |
|  |                     | Fast-mode Plus                          | 0.26 | --  | --   |      |
|  |                     | High-speed mode C <sub>b</sub> = 400pF  | 160  | --  | --   |      |
|  |                     | High-speed mode C <sub>b</sub> = 100pF  | 160  | --  | --   |      |
| (Repeated) Start Setup Time                    | t <sub>SU;STA</sub> | Standard-mode                           | 4.7  | --  | --   | μs   |
|  |                     | Fast-mode                               | 0.6  | --  | --   |      |
|  |                     | Fast-mode Plus                          | 0.26 | --  | --   |      |
|  |                     | High-speed mode C <sub>b</sub> = 400 pF | 160  | --  | --   | ns   |
|  |                     | High-speed mode C <sub>b</sub> = 100 pF | 160  | --  | --   |      |
| STOP Condition Setup Time                      | t <sub>SU;STO</sub> | Standard-mode                           | 4    | --  | --   | μs   |
|  |                     | Fast-mode                               | 0.6  | --  | --   |      |
|  |                     | Fast-mode Plus                          | 0.26 | --  | --   |      |
|  |                     | High-speed mode C <sub>b</sub> = 400pF  | 160  | --  | --   | ns   |
|  |                     | High-speed mode C <sub>b</sub> = 100pF  | 160  | --  | --   |      |
| SDA Data Hold Time                             | t <sub>HD;DAT</sub> | Standard-mode                           | 0.1  | --  | --   | ns   |
|  |                     | Fast-mode                               | 0.1  | --  | --   |      |
|  |                     | Fast-mode Plus                          | 0.1  | --  | --   |      |
|  |                     | High-speed mode C <sub>b</sub> = 400pF  | 0.1  | --  | 150  |      |
|  |                     | High-speed mode C <sub>b</sub> = 100pF  | 0.1  | --  | 70   |      |
| SDA Valid Acknowledge Time                     | t <sub>VD;ACK</sub> | Standard-mode                           | --   | --  | 3.45 | μs   |
|  |                     | Fast-mode                               | --   | --  | 0.9  |      |
|  |                     | Fast-mode Plus                          | --   | --  | 0.45 |      |

| Parameter           | Symbol              | Test Conditions                        | Min  | Typ | Max | Unit |
|---------------------|---------------------|--|------|-----|-----|------|
| SDA Setup Time      | t <sub>SU;DAT</sub> | Standard-mode                          | 250  | --  | --  | ns   |
|                     |                     | Fast-mode                              | 100  | --  | --  |      |
|                     |                     | Fast-mode Plus                         | 50   | --  | --  |      |
|                     |                     | High-speed mode C <sub>b</sub> = 400pF | 10   | --  | --  |      |
|                     |                     | High-speed mode C <sub>b</sub> = 100pF | 10   | --  | --  |      |
| SCL Clock Low Time  | t <sub>LOW</sub>    | Standard-mode                          | 4.7  | --  | --  | μs   |
|                     |                     | Fast-mode                              | 1.3  | --  | --  |      |
|                     |                     | Fast-mode Plus                         | 0.5  | --  | --  |      |
|                     |                     | High-speed mode C <sub>b</sub> = 400pF | 320  | --  | --  | ns   |
|                     |                     | High-speed mode C <sub>b</sub> = 100pF | 160  | --  | --  |      |
| SCL Clock High Time | t <sub>HIGH</sub>   | Standard-mode                          | 4    | --  | --  | μs   |
|                     |                     | Fast-mode                              | 0.6  | --  | --  |      |
|                     |                     | Fast-mode Plus                         | 0.26 | --  | --  |      |
|                     |                     | High-speed mode C <sub>b</sub> = 400pF | 120  | --  | --  | ns   |
|                     |                     | High-speed mode C <sub>b</sub> = 100pF | 60   | --  | --  |      |

**Note 1.** Stresses beyond those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions may affect device reliability.

**Note 2.** θ<sub>JA</sub> is measured under natural convection (still air) at T<sub>A</sub> = 25°C with the component mounted on a high effective-thermal-conductivity four-layer test board on a JEDEC 51-7 thermal measurement standard.

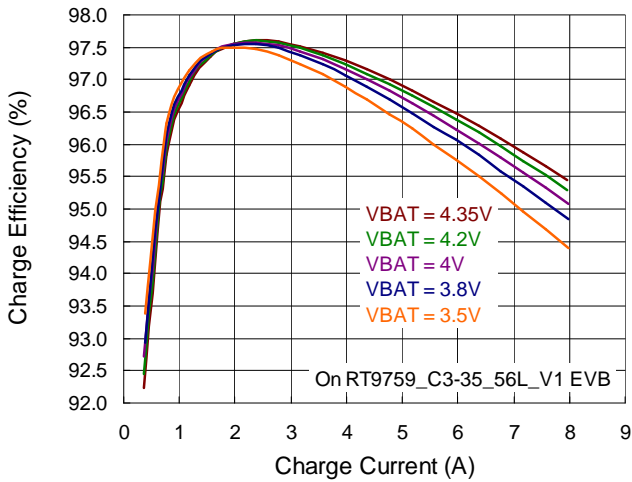
**Note 3.** Devices are ESD sensitive. Handling precaution is recommended.

**Note 4.** The device is not guaranteed to function outside its operating conditions.

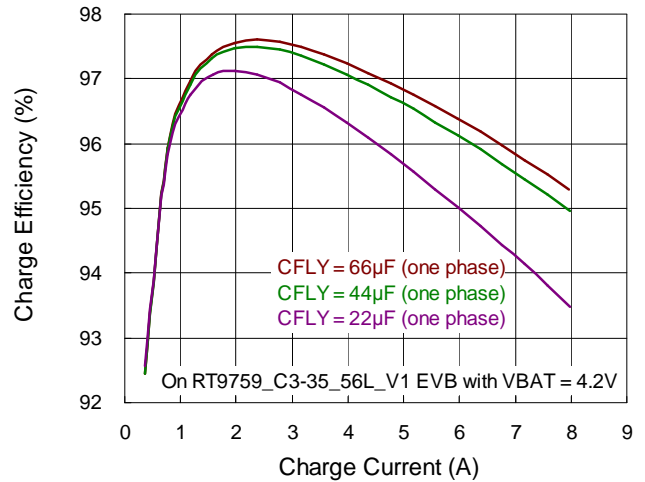
**Note 5.** Specification is guaranteed by design and/or correlation with statistical process control.

Typical Operating Characteristics

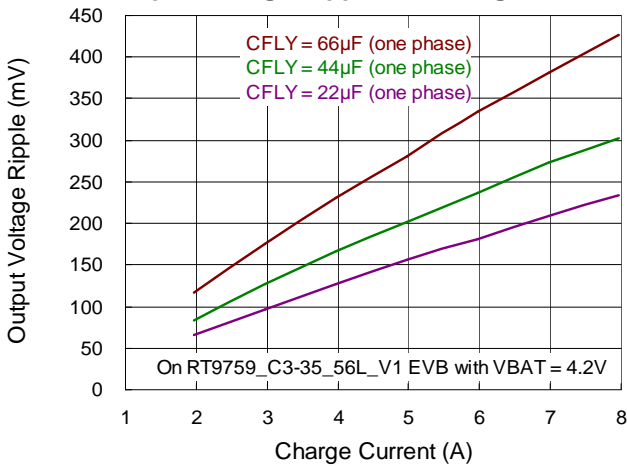
Charge Efficiency vs. Charge Current



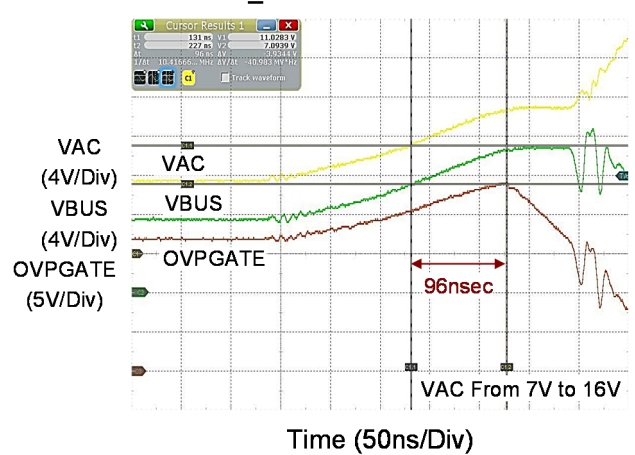
Charge Efficiency vs. Charge Current



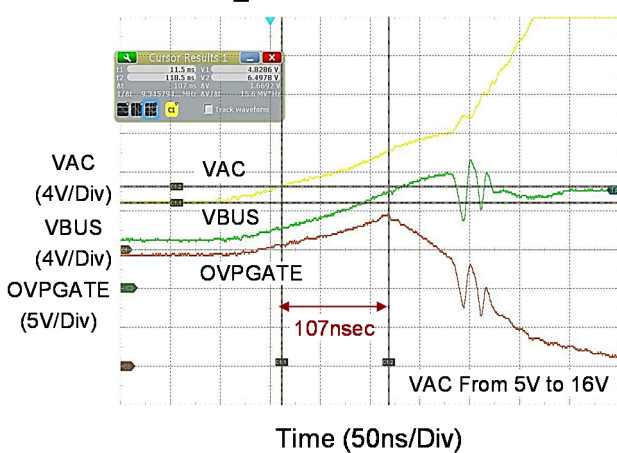
Output Voltage Ripple vs. Charge Current



VAC\_OVP 11V Test Waveform



VAC\_OVP 6.5V Test Waveform





**Register Descriptions**

**Register Map**

| Function Name        | STAT    | FLAG      | MASK    | Threshold | Enable    | Deglintch |
|----------------------|---------|-----------|---------|-----------|-----------|-----------|
| VBAT_OVP             | 0x10[7] | 0x11[7]   | 0x12[7] | 0x00[5:0] | 0x00[7]   | --        |
| IBAT_OCP             | 0x10[6] | 0x11[6]   | 0x12[6] | 0x02[6:0] | 0x02[7]   | --        |
| VAC_OVP              | 0x05[7] | 0x05[6]   | 0x05[5] | 0x05[2:0] | --        | --        |
| VDR_OVP              | 0x2C[1] | 0x2D[5]   | 0x2D[1] | 0x05[4]   | --        | 0x05[3]   |
| VBUS_OVP             | 0x10[5] | 0x11[5]   | 0x12[5] | 0x06[6:0] | --        | --        |
| IBUS_OCP             | 0x10[4] | 0x11[4]   | 0x12[4] | 0x08[3:0] | 0x08[7]   | --        |
| IBUS_UCP_RISE        | --      | 0x08[6]   | 0x08[5] | 0x2B[2]   | --        | --        |
| IBUS_UCP_FALL        | --      | 0x08[4]   | --      | 0x2B[2]   | --        | 0x2E[3]   |
| TDIE_OTP             | 0x0A[6] | 0x0A[7]   | --      | --        | 0x0C[0]   | --        |
| VBUS_LOW_ERR         | 0x0A[5] | --        | --      | --        | --        | 0x2E[4]   |
| VBUS_HIGH_ERR        | 0x0A[4] | --        | --      | --        | --        | --        |
| CFLY_DIAG_FLAG       | --      | 0x0A[0]   | --      | --        | --        | --        |
| VOUT_OVP             | 0x2C[0] | 0x2D[4]   | 0x2D[0] | --        | 0x2B[3]   | --        |
| CON_OCP              | --      | 0x0A[1]   | --      | --        | --        | --        |
| IBUS_UCP_TIMEOUT     | --      | 0x0A[3]   | --      | 0x2B[7:5] | 0x2B[7:5] | --        |
| VAC_INSERT_STAT      | 0x0D[2] | 0x0E[2]   | 0x0F[2] | --        | --        | --        |
| VOUT_INSERT_STAT     | 0x0D[1] | 0x0E[1]   | 0x0F[1] | --        | --        | --        |
| WDT                  | --      | 0x0B[3]   | --      | 0x0B[1:0] | 0x0B[2]   | --        |
| ADC_DONE             | 0x0D[0] | 0x0E[0]   | 0x0F[0] | --        | --        | --        |
| VBUS_PD              | --      | --        | --      | --        | 0x06[7]   | --        |
| VAC_PD               | --      | --        | --      | --        | 0x2B[0]   | --        |
| CON_SWITCHING        | 0x0A[2] | --        | --      | --        | --        | --        |
| TSBUS_OTP            | 0x10[1] | 0x11[1]   | 0x12[1] | 0x28[7:0] | 0x0C[2]   | --        |
| TSBAT_OTP            | 0x10[2] | 0x11[2]   | 0x12[2] | 0x29[7:0] | 0x0C[1]   | --        |
| VBAT_OVP_ALM         | 0x0D[7] | 0x0E[7]   | 0x0F[7] | 0x01[5:0] | 0x01[7]   | --        |
| IBAT_OCP_ALM         | 0x0D[6] | 0x0E[6]   | 0x0F[6] | 0x03[6:0] | 0x03[7]   | --        |
| IBAT_UCP_ALM         | 0x0D[3] | 0x0E[3]   | 0x0F[3] | 0x04[6:0] | 0x04[7]   | --        |
| VBUS_OVP_ALM         | 0x0D[5] | 0x0E[5]   | 0x0F[5] | 0x07[6:0] | 0x07[7]   | --        |
| TDIE_ALM             | 0x10[0] | 0x11[0]   | 0x12[0] | 0x2A[7:0] | --        | --        |
| IBUS_OCP_ALM         | 0x0D[4] | 0x0E[4]   | 0x0F[4] | 0x09[6:0] | 0x09[7]   | --        |
| TSBUS_TSBAT_ALM_STAT | 0x10[3] | 0x11[3]   | 0x12[3] | --        | --        | --        |
| IBAT_REG             | 0x2B[2] | 0x2D bit6 | 0x2D[2] | 0x2C[7:6] | --        | --        |
| VBAT_REG             | 0x2B[3] | 0x2D bit7 | 0x2D[3] | 0x2C[5:4] | --        | --        |
| Enable Regulation    | --      | --        | --      | --        | 0x2B[4]   | --        |

## Register Default Value

I<sup>2</sup>C Slave Address is 0x66 (Standalone1)

I<sup>2</sup>C Slave Address is 0x65 (Standalone2)

I<sup>2</sup>C Slave Address is 0x66 (Slave)

I<sup>2</sup>C Slave Address is 0x65 (Master)

| Register (Hex) | standalone1 (Hex) | standalone2 (Hex) | Slave (Hex) | Master (Hex) |
|----------------|-------------------|-------------------|-------------|--------------|
| 0x00           | 0x22              | 0x22              | 0xA2        | 0x22         |
| 0x01           | 0x1C              | 0x1C              | 0x9C        | 0x1C         |
| 0x02           | 0x3D              | 0x3D              | 0xBD        | 0x3D         |
| 0x03           | 0x3C              | 0x3C              | 0xBC        | 0x3C         |
| 0x04           | 0x28              | 0x28              | 0xA8        | 0x28         |
| 0x05           | 0x07              | 0x00              | 0x00        | 0x07         |
| 0x06           | 0x3A              | 0x3A              | 0x3A        | 0x3A         |
| 0x07           | 0x38              | 0x38              | 0xB8        | 0x38         |
| 0x08           | 0x0D              | 0x0D              | 0x0D        | 0x0D         |
| 0x09           | 0x50              | 0x50              | 0x50        | 0x50         |
| 0x0A           | 0x00              | 0x00              | 0x00        | 0x00         |
| 0x0B           | 0x40              | 0x40              | 0x40        | 0x40         |
| 0x0C           | 0x00              | 0x00              | 0x20        | 0x46         |
| 0x0D           | 0x00              | 0x00              | 0x00        | 0x00         |
| 0x0E           | 0x00              | 0x00              | 0x00        | 0x00         |
| 0x0F           | 0x00              | 0x00              | 0x00        | 0x00         |
| 0x10           | 0x00              | 0x00              | 0x00        | 0x00         |
| 0x11           | 0x00              | 0x00              | 0x00        | 0x00         |
| 0x12           | 0x00              | 0x00              | 0x00        | 0x00         |
| 0x13           | 0x00              | 0x00              | 0x00        | 0x00         |
| 0x14           | 0x00              | 0x00              | 0x00        | 0x00         |
| 0x15           | 0x00              | 0x00              | 0xF8        | 0x06         |
| 0x16           | 0x00              | 0x00              | 0x00        | 0x00         |
| 0x17           | 0x00              | 0x00              | 0x00        | 0x00         |
| 0x18           | 0x00              | 0x00              | 0x00        | 0x00         |
| 0x19           | 0x00              | 0x00              | 0x00        | 0x00         |
| 0x1A           | 0x00              | 0x00              | 0x00        | 0x00         |
| 0x1B           | 0x00              | 0x00              | 0x00        | 0x00         |
| 0x1C           | 0x00              | 0x00              | 0x00        | 0x00         |
| 0x1D           | 0x00              | 0x00              | 0x00        | 0x00         |
| 0x1E           | 0x00              | 0x00              | 0x00        | 0x00         |
| 0x1F           | 0x00              | 0x00              | 0x00        | 0x00         |
| 0x20           | 0x00              | 0x00              | 0x00        | 0x00         |
| 0x21           | 0x00              | 0x00              | 0x00        | 0x00         |

| Register (Hex) | standalone1 (Hex) | standalone2 (Hex) | Slave (Hex) | Master (Hex) |
|----------------|-------------------|-------------------|-------------|--------------|
| 0x22           | 0x00              | 0x00              | 0x00        | 0x00         |
| 0x23           | 0x00              | 0x00              | 0x00        | 0x00         |
| 0x24           | 0x00              | 0x00              | 0x00        | 0x00         |
| 0x25           | 0x00              | 0x00              | 0x00        | 0x00         |
| 0x26           | 0x00              | 0x00              | 0x00        | 0x00         |
| 0x27           | 0x00              | 0x00              | 0x00        | 0x00         |
| 0x28           | 0x15              | 0x15              | 0x15        | 0x15         |
| 0x29           | 0x15              | 0x15              | 0x15        | 0x15         |
| 0x2A           | 0xC8              | 0xC8              | 0xC8        | 0xC8         |
| 0x2B           | 0xE0              | 0xE0              | 0xE0        | 0xE0         |
| 0x2C           | 0x00              | 0x00              | 0x00        | 0x00         |
| 0x2D           | 0x00              | 0x00              | 0x00        | 0x00         |
| 0x2E           | 0x00              | 0x00              | 0x00        | 0x00         |

## Default Reset for standalone1

R : Read only

R/W : Read and write

Register Address : 0x00, Register Name : VBAT\_OVP

| Bit | Bit Name     | Default | WDT RST | REG RST | Type | Description   |
|-----|--------------|---------|---------|---------|------|---|
| 7   | VBAT_OVP_DIS | 0       | N       | Y       | R/W  | Battery over-voltage protection control.<br>0 : Enable (Default)<br>1 : Disable<br>Default for slave = 1                |
| 6   | Reversed     | 0       | NA      | NA      | NA   | Reversed  |
| 5:0 | VBAT_OVP     | 100010  | N       | Y       | R/W  | Battery over-voltage protection threshold.<br>$VBAT\_OVP = 3.5V + REG[5:0] \times LSB$<br>LSB = 25mV<br>Default = 4.35V |

Register Address : 0x01, Register Name : VBAT\_OVP\_ALM

| Bit | Bit Name         | Default | WDT RST | REG RST | Type | Description  |
|-----|------------------|---------|---------|---------|------|--|
| 7   | VBAT_OVP_ALM_DIS | 0       | N       | Y       | R/W  | Battery over-voltage alarm control.<br>0 : Enable (Default)<br>1 : Disable<br>Default for slave= 1                     |
| 6   | Reversed         | 0       | NA      | NA      | NA   | Reversed   |
| 5:0 | VBAT_OVP_ALM     | 011100  | N       | Y       | R/W  | Battery over-voltage alarm threshold.<br>$VBAT\_OVP\_ALM = 3.5V + REG[5:0] \times LSB$<br>LSB = 25mV<br>Default = 4.2V |

Register Address : 0x02, Register Name : IBAT\_OCP

| Bit | Bit Name     | Default | WDT RST | REG RST | Type | Description   |
|-----|--------------|---------|---------|---------|------|---|
| 7   | IBAT_OCP_DIS | 0       | N       | Y       | R/W  | Battery over-current protection control.<br>0 : Enable (Default)<br>1 : Disable<br>Default for slave = 1  |
| 6:0 | IBAT_OCP     | 0111101 | N       | Y       | R/W  | Battery over-current protection threshold<br>$IBAT\_OCP = 2A + REG[6:0] \times LSB$<br>LSB = 100mA<br>Default = 8.1A<br>Any setting over 10A is set to 10A. |

Register Address : 0x03, Register Name : IBAT\_OCP\_ALM

| Bit | Bit Name         | Default | WDT RST | REG RST | Type | Description   |
|-----|------------------|---------|---------|---------|------|---|
| 7   | IBAT_OCP_ALM_DIS | 0       | N       | Y       | R/W  | Battery over-current alarm control.<br>0 : Enable (Default)<br>1 : Disable<br>Default for slave = 1       |
| 6:0 | IBAT_OCP_ALM     | 0111100 | N       | Y       | R/W  | Battery over-current alarm threshold<br>IBAT_OCP_ALM = 2A + REG[6:0] x LSB<br>LSB = 100mA<br>Default = 8A |

Register Address : 0x04, Register Name : IBAT\_UCP\_ALM

| Bit | Bit Name         | Default | WDT RST | REG RST | Type | Description  |
|-----|------------------|---------|---------|---------|------|--|
| 7   | IBAT_UCP_ALM_DIS | 0       | N       | Y       | R/W  | IBAT_UCP_ALM disable bit<br>0 : Enable (Default)<br>1 : Disable<br>Default for slave = 1             |
| 6:0 | IBAT_UCP_ALM     | 0101000 | N       | Y       | R/W  | Battery under-current alarm threshold<br>IBAT_UCP_ALM = REG[6:0] x LSB<br>LSB = 50mA<br>Default = 2A |

Register Address : 0x05, Register Name : AC\_PROTECTION

| Bit | Bit Name              | Default | WDT RST | REG RST | Type | Description  |
|-----|-----------------------|---------|---------|---------|------|--|
| 7   | VAC_OVP_STAT          | 0       | N       | N       | R    | Set 1 when a VAC_OVP event occurs. Persists until condition is no longer valid.<br>0 : No VAC_OVP Fault<br>1 : VAC_OVP Fault is occurring  |
| 6   | VAC_OVP_FLAG          | 0       | N       | N       | R    | Set 1 when a VAC_OVP event occurs. Cleared upon read.<br>0 : No VAC_OVP Fault<br>1 : VAC_OVP Fault has occurred  |
| 5   | VAC_OVP_MASK          | 0       | N       | Y       | R/W  | Mask VAC_OVP event to send $\overline{INT}$ .<br>0 : Not masked (Default)<br>1 : Masked  |
| 4   | VDR_OVP_THRESHOLD_SET | 0       | N       | N       | R/W  | This is the voltage difference between VAC and VBUS that will cause the device to stop switching.<br>0 : 300mV (Default)<br>1 : 400mV  |
| 3   | VDR_OVP_DEGLITCH_SET  | 0       | N       | Y       | R/W  | This is the deglitch time after the device reaches the VDR_OVP threshold before the part stops switching.<br>0 : 8 $\mu$ s (Default)<br>1 : 5ms  |
| 2:0 | VAC_OVP               | 111     | N       | Y       | R/W  | 000-110 setting is determined by $VAC\_OVP = 11V + VAC\_OVP[3:0] \times 1V$<br>Writing all 1 to these bits set the VAC_OVP to 6.5V.<br>Default for slave = 000.<br>Default for standalone2 = 000 |

Register Address : 0x06, Register Name : VBUS\_OVP

| Bit | Bit Name   | Default | WDT RST | REG RST | Type | Description  |
|-----|------------|---------|---------|---------|------|--|
| 7   | VBUS_PD_EN | 0       | N       | Y       | R/W  | VBUS pull down resistor enable bit.<br>0 : Pull down disable (Default)<br>1 : Pull down enable               |
| 6:0 | VBUS_OVP   | 0111010 | N       | Y       | R/W  | VBUS over-voltage protection threshold.<br>$VBUS\_OVP = 6V + VBUS\_OVP[6:0] \times 50mV$ ,<br>Default = 8.9V |

Register Address : 0x07, Register Name : VBUS\_OVP\_ALM

| Bit | Bit Name         | Default | WDT RST | REG RST | Type | Description  |
|-----|------------------|---------|---------|---------|------|--|
| 7   | VBUS_OVP_ALM_DIS | 0       | N       | Y       | R/W  | VBUS over-voltage alarm disable bit.<br>0 : Enable (Default)<br>1 : Disable<br>Default for slave = 1     |
| 6:0 | VBUS_OVP_ALM     | 0111000 | N       | Y       | R/W  | VBUS over-voltage alarm threshold.<br>VBUS_OVP_ALM = 6V +<br>VBUS_OVP_ALM[6:0] x 50mV,<br>Default : 8.8V |

Register Address : 0x08, Register Name : IBUS\_OCP\_UCP

| Bit | Bit Name           | Default | WDT RST | REG RST | Type | Description   |
|-----|--------------------|---------|---------|---------|------|---|
| 7   | IBUS_OCP_DIS       | 0       | N       | Y       | R/W  | IBUS_OCP_ALM disable bit<br>0 : Enable (Default)<br>1 : Disable   |
| 6   | IBUS_UCP_RISE_FLAG | 0       | N       | N       | R    | Set 1 and send an $\overline{INT}$ when IBUS current larger than IBUS_UCP_RISE threshold. Clear upon read.<br>0 : No IBUS_UCP_RISE<br>1 : IBUS_UCP_RISE event has occurred  |
| 5   | IBUS_UCP_RISE_MASK | 0       | N       | Y       | R/W  | Masks an IBUS_UCP_RISE event to send an $\overline{INT}$<br>0 : Not masked (Default)<br>1 : Masked  |
| 4   | IBUS_UCP_FALL_FLAG | 0       | N       | N       | R    | Set 1 and send an $\overline{INT}$ when IBUS current smaller than IBUS_UCP_FALL threshold. Clear upon read.<br>0 : No IBUS_UCP_FALL<br>1 : IBUS_UCP_FALL event has occurred |
| 3:0 | IBUS_OCP           | 1101    | N       | Y       | R/W  | IBUS over-current protection threshold.<br>IBUS_OCP = 1A + IBUS_OCP[3:0] x 250mA,<br>Default : 4.25A  |

Register Address : 0x09, Register Name : IBUS\_OCP\_ALM

| Bit | Bit Name         | Default | WDT RST | REG RST | Type | Description  |
|-----|------------------|---------|---------|---------|------|--|
| 7   | IBUS_OCP_ALM_DIS | 0       | N       | Y       | R/W  | IBUS_OCP_ALM disable bit.<br>0 : Enable (Default)<br>1 : Disable                                     |
| 6:0 | IBUS_OCP_ALM     | 1010000 | N       | Y       | R/W  | IBUS over-current alarm threshold.<br>IBUS_OCP_ALM[6:0] x 50mA<br>Writing all 0's is 0A Default : 4A |

Register Address : 0x0A, Register Name : CONVERTER\_STATE

| Bit | Bit Name              | Default | WDT RST | REG RST | Type | Description   |
|-----|-----------------------|---------|---------|---------|------|---|
| 7   | TDIE_OTP_FLAG         | 0       | N       | N       | R    | Set 1 and send an $\overline{\text{INT}}$ when die temperature higher than TDIE threshold. Clear upon read.<br>0 : Normal<br>1 : TDIE_OTP has occurred  |
| 6   | TDIE_OTP_STAT         | 0       | N       | N       | R    | Set 1 when die temperature higher than TDIE threshold. Persists until condition is no longer valid.<br>0 : Normal<br>1 : TDIE_OTP is occurring  |
| 5   | VBUS_LOW_ERR_STAT     | 0       | N       | N       | R    | Set 1 when VBUS voltage lower than VBUS_LOW_ERR threshold. Persists until condition is no longer valid. This status only active before switching.<br>0 : Normal<br>1 : VBUS_LOW_ERR is occurring  |
| 4   | VBUS_HIGH_ERR_STAT    | 0       | N       | N       | R    | Set 1 when VBUS is higher than VBUS_HIGH_ERR threshold. Persists until condition is no longer valid. This status only active before switching.<br>0 : Normal<br>1 : VBUS_HGIH_ERR is occurring  |
| 3   | IBUS_UCP_TIMEOUT_FLAG | 0       | N       | N       | R    | Set 1 and send an $\overline{\text{INT}}$ when IBUS is not ramped to the IBUS_UCP_RISE threshold in IBUS_UCP_TIMEOUT time after CHG_EN = 1, Cleared upon read.<br>0 : Normal<br>1 : IBUS_UCP_TIMEOUT has occurred   |
| 2   | SWITCHING_STAT        | 0       | N       | N       | R    | Set 1 and send an $\overline{\text{INT}}$ when the converter start switching and IBUS_UCP_TIMEOUT timer start. Only one $\overline{\text{INT}}$ is sent when switching starts. Persists until condition is no longer valid.<br>0 : Normal<br>1 : SWITCHING is occurring |
| 1   | CON_OCP_FLAG          | 0       | N       | N       | R    | Set 1 and send an $\overline{\text{INT}}$ when converter current larger than CON_OCP threshold. Clear upon read.<br>0 : Normal<br>1 : CON_OCP has occurred  |
| 0   | CFLY_DIAG_FLAG        | 0       | N       | N       | R    | Set 1 and send an $\overline{\text{INT}}$ when CFLY short during converter soft-start. Clear upon read.<br>0 : Normal<br>1 : CFLY_DIG has occurred  |



Register Address : 0x0B, Register Name : CHG\_CTL

| Bit | Bit Name  | Default | WDT RST | REG RST | Type | Description  |
|-----|-----------|---------|---------|---------|------|--|
| 7   | REG_RST   | 0       | N       | Y       | R/W  | Register reset<br>0 : No register reset (Default)<br>1 : Reset registers   |
| 6:5 | FSW_SET   | 10      | N       | N       | R/W  | Set the switching frequency<br>00 : 250kHz<br>01 : 375kHz<br>10 : 500kHz (Default)<br>11 : 750kHz                        |
| 4   | Reserved  | 0       | NA      | NA      | NA   | Reserved   |
| 3   | WDT_FLAG  | 0       | N       | N       | R    | Set 1 and send an $\overline{INT}$ when watchdog time out happen. Clear upon read.<br>0 : Normal<br>1 : WDT has occurred |
| 2   | WDT_DIS   | 0       | N       | Y       | R/W  | Watchdog disable<br>0 : Enabled (Default)<br>1 : Disabled  |
| 1:0 | WDT_TIMER | 00      | N       | Y       | R/W  | Watchdog timer setting.<br>00 : 0.5s (Default)<br>01 : 1s<br>10 : 5s<br>11 : 30s   |

Register Address : 0x0C, Register Name : CHG\_CTL1

| Bit | Bit Name      | Default | WDT RST | REG RST | Type | Description  |
|-----|---------------|---------|---------|---------|------|--|
| 7   | CHG_EN        | 0       | Y       | Y       | R/W  | Charger control bit<br>0 : Charger disable (Default)<br>1 : Charge enable  |
| 6:5 | MS            | 00      | N       | N       | R    | Master, Slave, or Standalone operation.<br>00 : Standalone<br>01 : Slave<br>1X : Master  |
| 4:3 | CHG_FSHIFT    | 00      | N       | Y       | R/W  | Adjust switching frequency for EMI<br>00 : Nominal frequency (Default)<br>01 : Nominal frequency + 10%<br>10 : Nominal frequency - 10%<br>11 : Spread spectrum |
| 2   | TSBUS_OTP_DIS | 0       | N       | Y       | R/W  | TSBUS over-temperature protection disable bit.<br>0 : Enable (Default)<br>1 : Disable<br>Default for master = 1  |
| 1   | TSBAT_OTP_DIS | 0       | N       | Y       | R/W  | TSBAT over-temperature protection disable bit.<br>0 : Enable (Default)<br>1 : Disable<br>Default for master = 1  |
| 0   | TDIE_OTP_DIS  | 0       | N       | Y       | R/W  | TDIE over-temperature protection disable bit.<br>0 : Enable (Default)<br>1 : Disable   |

Register Address : 0x0D, Register Name : INT\_STAT

| Bit | Bit Name          | Default | WDT RST | REG RST | Type | Description  |
|-----|-------------------|---------|---------|---------|------|--|
| 7   | VBAT_OVP_ALM_STAT | 0       | N       | N       | R    | Set 1 when VBAT is higher than VBAT_OVP_ALM threshold. Persists until condition is no longer valid.<br>0 : Normal<br>1 : VBAT_OVP_ALM is occurring   |
| 6   | IBAT_OCP_ALM_STAT | 0       | N       | N       | R    | Set 1 when IBAT is larger than IBAT_OCP_ALM threshold. Persists until condition is no longer valid.<br>0 : Normal<br>1 : IBAT_OCP_ALM is occurring   |
| 5   | VBUS_OVP_ALM_STAT | 0       | N       | N       | R    | Set 1 when VBUS is higher than VBUS_OVP_ALM threshold. Persists until condition is no longer valid.<br>0 : Normal<br>1 : VBUS_OVP_ALM is occurring   |
| 4   | IBUS_OCP_ALM_STAT | 0       | N       | N       | R    | Set 1 when IBUS is larger than IBUS_OCP_ALM threshold. Persists until condition is no longer valid.<br>0 : Normal<br>1 : IBUS_OCP_ALM is occurring   |
| 3   | IBAT_UCP_ALM_STAT | 0       | N       | N       | R    | Set 1 when IBAT is smaller than IBAT_UCP_ALM threshold. Persists until condition is no longer valid.<br>0 : Normal<br>1 : IBAT_UCP_ALM is occurring  |
| 2   | VAC_INSERT_STAT   | 0       | N       | N       | R    | Set 1 when VAC voltage above the VAC_INSERT threshold<br>0 : Normal<br>1 : VAC_INSERT is occurring   |
| 1   | VOUT_INSERT_STAT  | 0       | N       | N       | R    | Set 1 when VOUT voltage above the VOUT_INSERT threshold<br>0 : Normal<br>1 : VOUT_INSERT is occurring  |
| 0   | ADC_DONE_STAT     | 0       | N       | N       | R    | Set 1 when the ADC conversion is completed in 1-shot mode. This bit will change to '0' when an ADC conversion is requested in 1-shot mode, and it will change back to '1' when the conversion is complete. During continuous conversion mode, this bit will be '0'<br>0 : Conversion not complete<br>1 : Conversion complete |

Register Address : 0x0E, Register Name : INT\_FLAG

| Bit | Bit Name          | Default | WDT RST | REG RST | Type | Description  |
|-----|-------------------|---------|---------|---------|------|--|
| 7   | VBAT_OVP_ALM_FLAG | 0       | N       | N       | R    | Set 1 and send an $\overline{\text{INT}}$ when VBAT higher than VBAT_OVP_ALM threshold. Clear upon read.<br>0 : Normal<br>1 : VBAT_OVP_ALM has occurred  |
| 6   | IBAT_OCP_ALM_FLAG | 0       | N       | N       | R    | Set 1 and send an $\overline{\text{INT}}$ when IBAT larger than IBAT_OCP_ALM threshold. Clear upon read.<br>0 : Normal<br>1 : IBAT_OCP_ALM has occurred  |
| 5   | VBUS_OVP_ALM_FLAG | 0       | N       | N       | R    | Set 1 and send an $\overline{\text{INT}}$ when VBUS higher than VBUS_OVP_ALM threshold. Clear upon read.<br>0 : Normal<br>1 : VBUS_OVP_ALM has occurred  |
| 4   | IBUS_OCP_ALM_FLAG | 0       | N       | N       | R    | Set 1 and send an $\overline{\text{INT}}$ when IBUS larger than IBUS_OCP_ALM threshold. Clear upon read.<br>0 : Normal<br>1 : IBUS_OCP_ALM has occurred  |
| 3   | IBAT_UCP_ALM_FLAG | 0       | N       | N       | R    | Set 1 and send an $\overline{\text{INT}}$ when IBAT smaller than IBAT_UCP_ALM threshold. Clear upon read.<br>0 : Normal<br>1 : IBAT_UCP_ALM has occurred |
| 2   | VAC_INSERT_FLAG   | 0       | N       | N       | R    | Set 1 and send an $\overline{\text{INT}}$ when VAC higher than VAC_INSERT threshold. Clear upon read.<br>0 : Normal<br>1 : VAC_INSERT has occurred       |
| 1   | VOUT_INSERT_FLAG  | 0       | N       | N       | R    | Set 1 and send an $\overline{\text{INT}}$ when VOUT higher than VOUT_INSERT threshold. Clear upon read.<br>0 : Normal<br>1 : VOUT_INSERT has occurred    |
| 0   | ADC_DONE_FLAG     | 0       | N       | N       | R    | Set 1 and send an $\overline{\text{INT}}$ when ADC conversion is completed in 1-shot mode. Clear upon read.<br>0 : Normal<br>1 : Conversion completed    |

Register Address : 0x0F, Register Name : INT\_MASK

| Bit | Bit Name          | Default | WDT RST | REG RST | Type | Description  |
|-----|-------------------|---------|---------|---------|------|--|
| 7   | VBAT_OVP_ALM_MASK | 0       | N       | Y       | R/W  | VBAT_OVP_ALM mask.<br>0 : Not masked (Default)<br>1 : Masked |
| 6   | IBAT_OCP_ALM_MASK | 0       | N       | Y       | R/W  | IBAT_OCP_ALM mask.<br>0 : Not masked (Default)<br>1 : Masked |
| 5   | VBUS_OVP_ALM_MASK | 0       | N       | Y       | R/W  | VBUS_OVP_ALM mask.<br>0 : Not masked (Default)<br>1 : Masked |
| 4   | IBUS_OCP_ALM_MASK | 0       | N       | Y       | R/W  | IBUS_OCP_ALM mask.<br>0 : Not masked (Default)<br>1 : Masked |
| 3   | IBAT_UCP_ALM_MASK | 0       | N       | Y       | R/W  | IBAT_UCP_ALM mask.<br>0 : Not masked (Default)<br>1 : Masked |
| 2   | VAC_INSERT_MASK   | 0       | N       | Y       | R/W  | VAC_INSERT mask.<br>0 : Not masked (Default)<br>1 : Masked   |
| 1   | VOUT_INSERT_MASK  | 0       | N       | Y       | R/W  | VOUT_INSERT mask.<br>0 : Not masked (Default)<br>1 : Masked  |
| 0   | ADC_DONE_MASK     | 0       | N       | Y       | R/W  | ADC_DONE mask.<br>0 : Not masked (Default)<br>1 : Masked     |

Register Address : 0x10, Register Name : FLT\_STAT

| Bit | Bit Name                 | Default | WDT RST | REG RST | Type | Description  |
|-----|--------------------------|---------|---------|---------|------|--|
| 7   | VBAT_OVP_STAT            | 0       | N       | N       | R    | Set 1 when VBAT is higher than VBAT_OVP threshold. Persists until condition is no longer valid.<br>0 : Normal<br>1 : VBAT_OVP is occurring                                     |
| 6   | IBAT_OCP_STAT            | 0       | N       | N       | R    | Set 1 when IBAT is larger than IBAT_OCP threshold. Persists until condition is no longer valid.<br>0 : Normal<br>1 : IBAT_OCP is occurring                                     |
| 5   | VBUS_OVP_STAT            | 0       | N       | N       | R    | Set 1 and send an $\overline{\text{INT}}$ when VBUS is higher than VBUS_OVP threshold. Persists until condition is no longer valid.<br>0 : Normal<br>1 : VBUS_OVP has occurred |
| 4   | IBUS_OCP_STAT            | 0       | N       | N       | R    | Set 1 when IBUS is larger than IBUS_OCP threshold. Persists until condition is no longer valid.<br>0 : Normal<br>1 : IBUS_OCP is occurring                                     |
| 3   | TSBUS_TSBAT_OTP_ALM_STAT | 0       | N       | N       | R    | Set 1 when the TSBUS or TSBAT threshold has been within 5% of the TSBUS_OTP or TSBAT_OTP set threshold.<br>0 : Normal<br>1 : TSBUS_TSBAT_OTP_ALM is occurring                  |
| 2   | TSBAT_OTP_STAT           | 0       | N       | N       | R    | Set 1 when the TSBAT lower than TSBUS_OTP set threshold<br>0 : Normal<br>1 : TSBUS_OTP is occurring  |
| 1   | TSBUS_OTP_STAT           | 0       | N       | N       | R    | Set 1 when the TSBUS lower than TSBUS_OTP set threshold<br>0 : Normal<br>1 : TSBUS_OTP is occurring  |
| 0   | TDIE_OTP_ALM_STAT        | 0       | N       | N       | R    | Set 1 when die temperature over TDIE_OTP_ALM threshold. Persists until condition is no longer valid.<br>0 : Normal<br>1 : TDIE_OTP_ALM is occurring                            |

Register Address : 0x11, Register Name : FLT\_FLAG

| Bit | Bit Name                 | Default | WDT RST | REG RST | Type | Description  |
|-----|--------------------------|---------|---------|---------|------|--|
| 7   | VBAT_OVP_FLAG            | 0       | N       | N       | R    | Set 1 and send an $\overline{\text{INT}}$ when VBAT is higher than VBAT_OVP threshold. Clear upon read.<br>0 : Normal<br>1 : VBAT_OVP has occurred                             |
| 6   | IBAT_OCP_FLAG            | 0       | N       | N       | R    | Set 1 and send an $\overline{\text{INT}}$ when IBAT is larger than IBAT_OCP threshold. Clear upon read.<br>0 : Normal<br>1 : IBAT_OCP has occurred                             |
| 5   | VBUS_OVP_FLAG            | 0       | N       | N       | R    | Set 1 and send an $\overline{\text{INT}}$ when VBUS is higher than VBUS_OVP threshold. Clear upon read.<br>0 : Normal<br>1 : VBUS_OVP has occurred                             |
| 4   | IBUS_OCP_FLAG            | 0       | N       | N       | R    | Set 1 and send an $\overline{\text{INT}}$ when IBUS is larger than IBUS_OCP threshold. Clear upon read.<br>0 : Normal<br>1 : IBUS_OCP has occurred                             |
| 3   | TSBUS_TSBAT_OTP_ALM_FLAG | 0       | N       | N       | R    | Set 1 when the TSBUS or TSBAT threshold has been within 5% of the TSBUS_OTP or TSBAT_OTP set threshold. Clear upon read.<br>0 : Normal<br>1 : TSBUS_TSBAT_OTP_ALM has occurred |
| 2   | TSBAT_OTP_FLAG           | 0       | N       | N       | R    | Set 1 and send an $\overline{\text{INT}}$ when TSBAT lower than TSBAT_OTP threshold. Clear upon read.<br>0 : Normal<br>1 : TSBAT_OTP has occurred                              |
| 1   | TSBUS_OTP_FLAG           | 0       | N       | N       | R    | Set 1 and send an $\overline{\text{INT}}$ when TSBUS lower than TSBUS_OTP threshold. Clear upon read.<br>0 : Normal<br>1 : TSBUS_OTP has occurred                              |
| 0   | TDIE_OTP_ALM_FLAG        | 0       | N       | N       | R    | Set 1 and send an $\overline{\text{INT}}$ when TDIE is higher than TDIE_OTP_ALM threshold. Clear upon read.<br>0 : Normal<br>1 : TDIE_OTP_ALM has occurred                     |

Register Address : 0x12, Register Name : FLT\_MASK

| Bit | Bit Name                 | Default | WDT RST | REG RST | Type | Description  |
|-----|--------------------------|---------|---------|---------|------|--|
| 7   | VBAT_OVP_MASK            | 0       | N       | Y       | R/W  | Masks a VBAT_OVP event to send an $\overline{\text{INT}}$ .<br>0 : Not masked (Default)<br>1 : Masked            |
| 6   | IBAT_OCP_MASK            | 0       | N       | Y       | R/W  | Masks an IBAT_OCP event to send an $\overline{\text{INT}}$ .<br>0 : Not masked (Default)<br>1 : Masked           |
| 5   | VBUS_OVP_MASK            | 0       | N       | Y       | R/W  | Masks a VBUS_OVP event to send an $\overline{\text{INT}}$ .<br>0 : Not masked (Default)<br>1 : Masked            |
| 4   | IBUS_OCP_MASK            | 0       | N       | Y       | R/W  | Masks an IBUS_OCP event to send an $\overline{\text{INT}}$ .<br>0 : Not masked (Default)<br>1 : Masked           |
| 3   | TSBUS_TSBAT_OTP_ALM_MASK | 0       | N       | Y       | R/W  | Masks a TSBUS_TSBAT_OTP_ALM event to send an $\overline{\text{INT}}$ .<br>0 : Not masked (Default)<br>1 : Masked |
| 2   | TSBAT_OTP_MASK           | 0       | N       | Y       | R/W  | Masks a TSBAT_OTP event to send an $\overline{\text{INT}}$ .<br>0 : Not masked (Default)<br>1 : Masked           |
| 1   | TSBUS_OTP_MASK           | 0       | N       | Y       | R/W  | Masks a TSBUS_OTP event to send an $\overline{\text{INT}}$ .<br>0 : Not masked (Default)<br>1 : Masked           |
| 0   | TDIE_OTP_ALM_MASK        | 0       | N       | Y       | R/W  | Masks a TDIE_OTP event to send an $\overline{\text{INT}}$ .<br>0 : Not masked (Default)<br>1 : Masked            |

Register Address : 0x13, Register Name : DEVICE\_INFO

| Bit | Bit Name        | Default | WDT RST | REG RST | Type | Description                |
|-----|-----------------|---------|---------|---------|------|----------------------------|
| 7:4 | Device Revision | 0000    | N       | N       | R    | Device Revision            |
| 3:0 | Device ID       | 1000    | N       | N       | R    | Device ID<br>1000 = RT9759 |



Register Address : 0x14, Register Name : ADC\_CTRL

| Bit | Bit Name     | Default | WDT RST | REG RST | Type | Description  |
|-----|--------------|---------|---------|---------|------|--|
| 7   | ADC_EN       | 0       | Y       | Y       | R/W  | ADC control<br>0 : Disable (Default)<br>1 : Enable   |
| 6   | ADC_RATE     | 0       | N       | Y       | R/W  | ADC conversion rate control<br>0 : Continuous mode (Default)<br>1 : 1-shot mode                        |
| 5:1 | Reversed     | 00000   | NA      | NA      | NA   | Reversed   |
| 0   | IBUS_ADC_DIS | 0       | N       | Y       | R/W  | IBUS_ADC control<br>0 : Enable conversion (Default)<br>1 : Disable conversion<br>Default for slave = 1 |

Register Address : 0x15, Register Name : ADC\_EN

| Bit | Bit Name      | Default | WDT RST | REG RST | Type | Description   |
|-----|---------------|---------|---------|---------|------|---|
| 7   | VBUS_ADC_DIS  | 0       | N       | Y       | R/W  | VBUS ADC control bit.<br>0 : Enable (Default)<br>1 : Disable<br>Default for slave = 1   |
| 6   | VAC_ADC_DIS   | 0       | N       | Y       | R/W  | VBAT_ADC control bit.<br>0 : Enable (Default)<br>1 : Disable<br>Default for slave = 1   |
| 5   | VOUT_ADC_DIS  | 0       | N       | Y       | R/W  | VOUT ADC control bit.<br>0 : Enable (Default)<br>1 : Disable<br>Default for slave = 1   |
| 4   | VBAT_ADC_DIS  | 0       | N       | Y       | R/W  | VBAT ADC control bit.<br>0 : Enable (Default)<br>1 : Disable<br>Default for slave = 1   |
| 3   | IBAT_ADC_DIS  | 0       | N       | Y       | R/W  | IBAT_ADC control bit.<br>0 : Enable (Default)<br>1 : Disable<br>Default for slave= 1    |
| 2   | TSBUS_ADC_DIS | 0       | N       | Y       | R/W  | TSBUS_ADC control bit.<br>0 : Enable (Default)<br>1 : Disable<br>Default for Master = 1 |
| 1   | TSBAT_ADC_DIS | 0       | N       | Y       | R/W  | TSBAT_ADC control bit.<br>0 : Enable (Default)<br>1 : Disable<br>Default for Master = 1 |
| 0   | TDIE_ADC_DIS  | 0       | N       | Y       | R/W  | TDIE_ADC control bit.<br>0 : Enable (Default)<br>1 : Disable                            |

Register Address : 0x16, Register Name : IBUS\_ADC1

| Bit | Bit Name  | Default | WDT RST | REG RST | Type | Description  |
|-----|-----------|---------|---------|---------|------|--|
| 7   | Reserved  | 0       | NA      | NA      | NA   | Reserved   |
| 6:0 | IBUS_ADC1 | 0000000 | N       | N       | R    | IBUS ADC high byte<br>HSB<6:0> : 16384mA, 8192mA, 4096mA, 2048mA, 1024mA, 512mA, 256mA |

Register Address : 0x17, Register Name : IBUS\_ADC0

| Bit | Bit Name  | Default  | WDT RST | REG RST | Type | Description   |
|-----|-----------|----------|---------|---------|------|---|
| 7:0 | IBUS_ADC0 | 00000000 | N       | N       | R    | IBUS ADC low byte<br>LSB<7:0> : 128mA, 64mA, 32mA, 16mA, 8mA, 4mA, 2mA, 1mA |

Register Address : 0x18, Register Name : VBUS\_ADC1

| Bit | Bit Name  | Default | WDT RST | REG RST | Type | Description  |
|-----|-----------|---------|---------|---------|------|--|
| 7   | Reserved  | 0       | NA      | NA      | NA   | Reserved   |
| 6:0 | VBUS_ADC1 | 0000000 | N       | N       | R    | VBUS ADC high byte<br>HSB<6:0> : 16384mV, 8192mV, 4096mV, 2048mV, 1024mV, 512mV, 256mV |

Register Address : 0x19, Register Name : VBUS\_ADC0

| Bit | Bit Name  | Default  | WDT RST | REG RST | Type | Description   |
|-----|-----------|----------|---------|---------|------|---|
| 7:0 | VBUS_ADC0 | 00000000 | N       | N       | R    | VBUS ADC low byte<br>LSB<7:0> : 128mV, 64mV, 32mV, 16mV, 8mV, 4mV, 2mV, 1mV |

Register Address : 0x1A, Register Name : VAC\_ADC1

| Bit | Bit Name | Default | WDT RST | REG RST | Type | Description   |
|-----|----------|---------|---------|---------|------|---|
| 7   | Reserved | 0       | NA      | NA      | NA   | Reserved  |
| 6:0 | VAC_ADC1 | 0000000 | N       | N       | R    | VAC ADC high byte<br>HSB<6:0> : 16384mV, 8192mV, 4096mV, 2048mV, 1024mV, 512mV, 256mV |

Register Address : 0x1B, Register Name : VAC\_ADC0

| Bit | Bit Name | Default  | WDT RST | REG RST | Type | Description  |
|-----|----------|----------|---------|---------|------|--|
| 7:0 | VAC_ADC0 | 00000000 | N       | N       | R    | VAC ADC low byte<br>LSB<7:0> : 128mV, 64mV, 32mV, 16mV, 8mV, 4mV, 2mV, 1mV |

Register Address : 0x1C, Register Name : VOUT\_ADC1

| Bit | Bit Name  | Default | WDT RST | REG RST | Type | Description  |
|-----|-----------|---------|---------|---------|------|--|
| 7   | Reserved  | 0       | NA      | NA      | NA   | Reserved   |
| 6:0 | VOUT_ADC1 | 0000000 | N       | N       | R    | VOUT ADC high byte<br>HSB<6:0> : 16384mV, 8192mV, 4096mV, 2048mV, 1024mV, 512mV, 256mV |

Register Address : 0x1D, Register Name : VOUT\_ADC0

| Bit | Bit Name  | Default  | WDT RST | REG RST | Type | Description   |
|-----|-----------|----------|---------|---------|------|---|
| 7:0 | VOUT_ADC0 | 00000000 | N       | N       | R    | VOUT ADC low byte<br>LSB<7:0> : 128mV, 64mV, 32mV, 16mV, 8mV, 4mV, 2mV, 1mV |

Register Address : 0x1E, Register Name : VBAT\_ADC1

| Bit | Bit Name  | Default | WDT RST | REG RST | Type | Description  |
|-----|-----------|---------|---------|---------|------|--|
| 7   | Reserved  | 0       | NA      | NA      | NA   | Reserved   |
| 6:0 | VBAT_ADC1 | 0000000 | N       | N       | R    | VBAT ADC high byte<br>HSB<6:0> : 16384mV, 8192mV, 4096mV, 2048mV, 1024mV, 512mV, 256mV |

Register Address : 0x1F, Register Name : VBAT\_ADC0

| Bit | Bit Name  | Default  | WDT RST | REG RST | Type | Description   |
|-----|-----------|----------|---------|---------|------|---|
| 7:0 | VBAT_ADC0 | 00000000 | N       | N       | R    | VBAT ADC low byte<br>LSB<7:0> : 128mV, 64mV, 32mV, 16mV, 8mV, 4mV, 2mV, 1mV |

Register Address : 0x20, Register Name : IBAT\_ADC1

| Bit | Bit Name  | Default | WDT RST | REG RST | Type | Description  |
|-----|-----------|---------|---------|---------|------|--|
| 7   | Reserved  | 0       | NA      | NA      | NA   | Reserved   |
| 6:0 | IBAT_ADC1 | 0000000 | N       | N       | R    | IBAT ADC high byte<br>HSB<6:0> : 16384mA, 8192mA, 4096mA, 2048mA, 1024mA, 512mA, 256mA |

Register Address : 0x21, Register Name : IBAT\_ADC0

| Bit | Bit Name  | Default  | WDT RST | REG RST | Type | Description   |
|-----|-----------|----------|---------|---------|------|---|
| 7:0 | IBAT_ADC0 | 00000000 | N       | N       | R    | IBAT ADC low byte<br>LSB<7:0> : 128mA, 64mA, 32mA, 16mA, 8mA, 4mA, 2mA, 1mA |

Register Address : 0x22, Register Name : TSBUS\_ADC1

| Bit | Bit Name   | Default | WDT RST | REG RST | Type | Description                                |
|-----|------------|---------|---------|---------|------|--|
| 7:2 | Reserved   | 000000  | NA      | NA      | NA   | Reserved                                   |
| 1:0 | TSBUS_ADC1 | 00      | N       | N       | R    | TSBUS ADC high byte<br>HSB<1:0> : 50%, 25% |

Register Address : 0x23, Register Name : TSBUS\_ADC0

| Bit | Bit Name   | Default  | WDT RST | REG RST | Type | Description   |
|-----|------------|----------|---------|---------|------|---|
| 7:0 | TSBUS_ADC0 | 00000000 | N       | N       | R    | TSBUS ADC low byte<br>LSB<7:0> : 12.5%, 6.25%, 3.125%, 1.5625%,<br>0.78125%, 0.39063%, 0.19531%, 0.09766% |

Register Address : 0x24, Register Name : TSBAT\_ADC1

| Bit | Bit Name   | Default | WDT RST | REG RST | Type | Description                                |
|-----|------------|---------|---------|---------|------|--|
| 7:2 | Reserved   | 000000  | NA      | NA      | NA   | Reserved                                   |
| 1:0 | TSBAT_ADC1 | 00      | N       | N       | R    | TSBAT ADC high byte<br>HSB<1:0> : 50%, 25% |

Register Address : 0x25, Register Name : TSBAT\_ADC0

| Bit | Bit Name   | Default  | WDT RST | REG RST | Type | Description   |
|-----|------------|----------|---------|---------|------|---|
| 7:0 | TSBAT_ADC0 | 00000000 | N       | N       | R    | TSBAT ADC low byte<br>LSB<7:0> : 12.5%, 6.25%, 3.125%, 1.5625%,<br>0.78125%, 0.39063%, 0.19531%, 0.09766% |

Register Address : 0x26 Register Name : TDIE\_ADC1

| Bit | Bit Name  | Default | WDT RST | REG RST | Type | Description                          |
|-----|-----------|---------|---------|---------|------|--------------------------------------|
| 7:1 | Reserved  | 0000000 | NA      | NA      | NA   | Reserved                             |
| 0   | TDIE_ADC1 | 0       | N       | N       | R    | TDIE ADC high byte<br>HSB<0> : 128°C |

Register Address : 0x27 Register Name : TDIE\_ADC0

| Bit | Bit Name  | Default  | WDT RST | REG RST | Type | Description  |
|-----|-----------|----------|---------|---------|------|--|
| 7:0 | TDIE_ADC0 | 00000000 | N       | N       | R    | TDIE ADC low byte<br>LSB<7:0> : 64°C, 32°C, 16°C, 8°C, 4°C, 2°C,<br>1°C, 0.5°C |

Register Address : 0x28 Register Name : TSBUS\_OTP

| Bit | Bit Name  | Default  | WDT RST | REG RST | Type | Description   |
|-----|-----------|----------|---------|---------|------|---|
| 7:0 | TSBUS_OTP | 00010101 | N       | Y       | R/W  | TSBUS Percentage Fault Threshold<br>$TSBUS\_FLT = TSBUS\_FLT[7:0] \times 0.19531\%$<br>Default = 4.1% |

Register Address : 0x29 Register Name : TSBAT\_OTP

| Bit | Bit Name  | Default  | WDT RST | REG RST | Type | Description   |
|-----|-----------|----------|---------|---------|------|---|
| 7:0 | TSBAT_OTP | 00010101 | N       | Y       | R/W  | TSBAT Percentage Fault Threshold<br>$TSBAT\_FLT = TSBAT\_FLT[7:0] \times 0.19531\%$<br>Default = 4.1% |

Register Address : 0x2A Register Name : TDIE\_ALM

| Bit | Bit Name | Default  | WDT RST | REG RST | Type | Description  |
|-----|----------|----------|---------|---------|------|--|
| 7:0 | TDIE_ALM | 11001000 | N       | Y       | R/W  | TDIE alarm fault threshold setting<br>$TDIE\_ALM = 25^{\circ}\text{C} + \text{REG}[7:0] \times 0.5^{\circ}\text{C}$<br>Default = 125°C |

Register Address : 0x2B, Register Name : REG\_CTRL

| Bit | Bit Name             | Default | WDT RST | REG RST | Type | Description  |
|-----|----------------------|---------|---------|---------|------|--|
| 7:5 | IBUS_UCP_TIMEOUT     | 111     | N       | N       | R/W  | Adjustable timeout for IBUS to rise to IBUS_UCP_RISE threshold.<br>000 : Timeout disabled<br>001 : 12.5ms<br>010 : 25ms<br>011 : 50ms<br>100 : 100ms<br>101 : 400ms<br>110 : 1.5s<br>111 : 100s (Default)                            |
| 4   | REG_EN               | 0       | N       | N       | R/W  | Enables the device to regulate the output based on VBAT_OVP and IBAT_OCP thresholds.<br>0 : Disable (Default)<br>1 : Enable  |
| 3   | VOUT_OVP_DIS         | 0       | N       | N       | R/W  | VOUT over-voltage control bit.<br>0 : Enable (Default)<br>1 : Disable  |
| 2   | IBUS_UCP_RISE_THRESH | 0       | N       | N       | R/W  | This bit is set the threshold IBUS_UCP_RISE threshold. The system should control the IBUS current rise to IBUS_UCP_RISE within the IBUS_UCP_TIMEOUT.<br>0 : 300mA rising, 150mA falling (Default)<br>1 : 500mA rising, 250mA falling |
| 1   | IBAT_RSEN            | 0       | N       | N       | R/W  | This bit selects the external battery current sense resistor value.<br>0 : 2mΩ (Default)<br>1 : 5mΩ  |
| 0   | VAC_PD_EN            | 0       | N       | N       | R/W  | VAC pull down resistor control bit.<br>0 : Disable (Default)<br>1 : Enable   |

Register Address : 0x2C, Register Name : REG\_THRESHOLD

| Bit | Bit Name      | Default | WDT RST | REG RST | Type | Description   |
|-----|---------------|---------|---------|---------|------|---|
| 7:6 | IBAT_REG      | 00      | N       | N       | R/W  | These two bits set the threshold below IBAT_OCP where the part starts regulation.<br>00 : 200mA below IBAT_OCP setting (Default)<br>01 : 300mA below IBAT_OCP setting<br>10 : 400mA below IBAT_OCP setting<br>11 : 500mA below IBAT_OCP setting |
| 5:4 | VBAT_REG      | 00      | N       | N       | R/W  | These two bits set the threshold below VBAT_OVP where the part starts regulation.<br>00 : 50mV below VBAT_OVP setting (Default)<br>01 : 100mV below VBAT_OVP setting<br>10 : 150mV below VBAT_OVP setting<br>11 : 200mV below VBAT_OVP setting  |
| 3   | VBAT_REG_STAT | 0       | N       | N       | R    | Set 1 when VBAT_REG is active. Persists until condition is no longer valid.<br>0 : Normal<br>1 : VBAT_REG is occurring  |
| 2   | IBAT_REG_STAT | 0       | N       | N       | R    | Set 1 when IBAT_REG is active. Persists until condition is no longer valid.<br>0 : Normal<br>1 : IBAT_REG is occurring  |
| 1   | VDR_OVP_STAT  | 0       | N       | N       | R    | Set 1 when the voltage difference between VAC and VBUS is higher than VDR_OVP threshold. Persists until condition is no longer valid.<br>0 : Normal<br>1 : VDR_OVP is occurring   |
| 0   | VOUT_OVP_STAT | 0       | N       | N       | R    | Set 1 when the VOUT is higher than VOUT_OVP threshold. Persists until condition is no longer valid.<br>0 : Normal<br>1 : VOUT_OVP is occurring  |

Register Address : 0x2D, Register Name : REG\_FLAG\_MASK

| Bit | Bit Name      | Default | WDT RST | REG RST | Type | Description  |
|-----|---------------|---------|---------|---------|------|--|
| 7   | VBAT_REG_FLAG | 0       | N       | N       | R    | Set 1 and send an $\overline{\text{INT}}$ when VBAT_REG has been active. Clear upon read.<br>0 : Normal<br>1 : VBAT_REG has occurred |
| 6   | IBAT_REG_FLAG | 0       | N       | N       | R    | Set 1 and send an $\overline{\text{INT}}$ when IBAT_REG has been active. Clear upon read.<br>0 : Normal<br>1 : IBAT_REG has occurred |
| 5   | VDR_OVP_FLAG  | 0       | N       | N       | R    | Set 1 and send an $\overline{\text{INT}}$ when VDR_OVP has occurred. Clear upon read.<br>0 : Normal<br>1 : VDR_OVP has occurred      |
| 4   | VOUT_OVP_FLAG | 0       | N       | N       | R    | Set 1 and send an $\overline{\text{INT}}$ when VOUT_OVP has occurred. Clear upon read.<br>0 : Normal<br>1 : VOUT_OVP has occurred    |
| 3   | VBAT_REG_MASK | 0       | N       | Y       | R/W  | Masks an VBAT_REG event to send an $\overline{\text{INT}}$<br>0 : Not masked (Default)<br>1 : Masked                                 |
| 2   | IBAT_REG_MASK | 0       | N       | Y       | R/W  | Masks an IBAT_REG event to send an $\overline{\text{INT}}$<br>0 : Not masked (Default)<br>1 : Masked                                 |
| 1   | VDR_OVP_MASK  | 0       | N       | Y       | R/W  | Masks an VDR_OVP event to send an $\overline{\text{INT}}$<br>0 : Not masked (Default)<br>1 : Masked                                  |
| 0   | VOUT_OVP_MASK | 0       | N       | Y       | R/W  | Masks an VOUT_OVP event to send an $\overline{\text{INT}}$<br>0 : Not masked (Default)<br>1 : Masked                                 |

Register Address : 0x2E, Register Name : REG\_STAT\_FLAG\_MASK

| Bit | Bit Name                    | Default | WDT RST | REG RST | Type | Description  |
|-----|-----------------------------|---------|---------|---------|------|--|
| 7:5 | Reversed                    | 000     | NA      | NA      | NA   | Reversed   |
| 4   | VBUS_LOW_ERR_DEGLIT_CH_SET  | 0       | N       | Y       | R/W  | This bit sets the deglitch time for VBUS_LOW_ERR<br>0 : 10 $\mu$ s (Default)<br>1 : 10ms |
| 3   | IBUS_UCP_FALL_DEGLIT_CH_SET | 0       | N       | Y       | R/W  | This bit sets the deglitch time for VBUS_UCP_FALL<br>0 : 10 $\mu$ s (Default)<br>1 : 5ms |
| 2:0 | Reversed                    | 000     | NA      | NA      | R/W  | Reversed   |



**Application Information**

**Operation Principle**

The cap divider topology relies on a smart wall adapter to control the voltage and current of input in order to charge. Based on the cap divider topology, the 4 MOSFETs (Q1 to Q4) are used to charge and discharge flying capacitor (CFLY) alternately. The simplified circuit of cap divider is shown in Figure 1.

In period 1: When Q1 and Q3 are turned on and Q2 and Q4 are turned off, the CFLY and BAT are in series with VBUS. The BUS current is supplied to COUT and BAT directly. During this period, the voltage of CFLY can be expressed as equation 1 :

$$VCFLY = VBUS - VBAT \text{ ---- (1)}$$

In period 2 : When Q1 and Q3 are turned off and Q2 and Q4 are turned on, the CFLY and BAT are in parallel. The current of BAT is only supplied by CFLY. During this period, the voltage of CFLY can be expressed as equation 2 :

$$VCFLY = VBAT \text{ ---- (2)}$$

If the equation 2 is substituted into equation 1, the equation 1 can be expressed as equation 3 :

$$VBAT = VBUS / 2 \text{ ---- (3)}$$

If the power dissipation of topology is ignored, the output power can be expressed as equation 4 :

$$VBAT \times IBAT = VBUS \times IBUS \text{ --- (4)}$$

If the equation 3 is substituted into equation 4, the IBAT can be expressed as equation 5 :

$$IBAT = 2 \times IBUS \text{ --- (5)}$$

According to the equations above, the battery voltage is half of the input voltage and the current flow into the battery is twice the input current in cap divider topology. For the efficiency and output ripple improvement in application, the dual phase cap divider topology with phase shift 180-degree between phases are built in the RT9759.

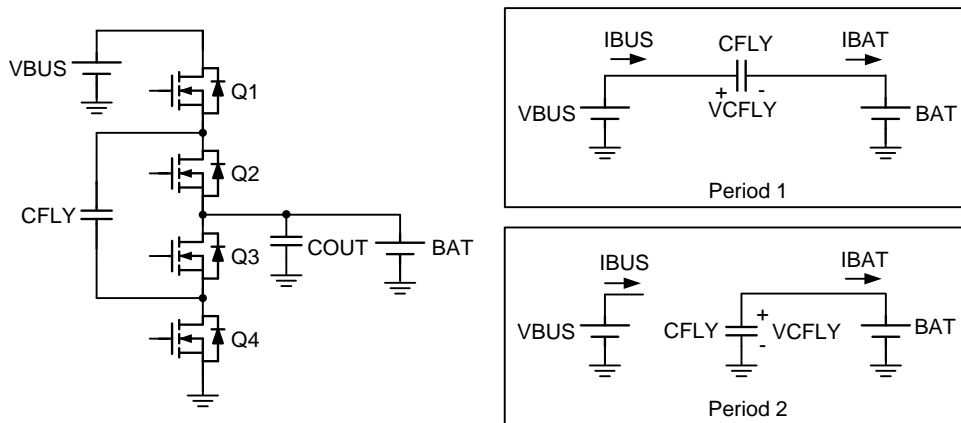


Figure 1. Simplified Circuit of Cap Divider

## Charge System Introduction

The RT9759 is a smart cap divider charger used in slave charger application. The RT9759 generates high output current with cap divider topology. Before enabling the RT9759, the host set up all of protection and alarm functions and disable main charger in power solution. The host must monitor the alarms that set up in RT9759 during high current charging period and communicate with the smart wall adapter to control the charging current flow into the battery.

The Figure 2 is the simplified charge system block. In this charge system, the switching charger is used to detect USB BC1.2 of adapter and the PD controller is used to communicate with adapter by PD protocol. Once the smart wall adapter is detected, the AP will

control the switching charger and smart cap divider charger to achieve high current charging period. These devices can communicate with each other through I<sup>2</sup>C serial interface.

The charge profile of high capacity battery using switching charger and cap divider charger is shown in Figure 3. In order to achieve the charge profile, the switching charger is required to dominate pre-charge, fast charge when battery voltage is lower than system startup voltage, constant voltage and termination periods, respectively. The cap divider charger is used to achieve fast charge period. To shorten the constant voltage period, the cap divider charger is controlled to reduce the charge current by ramp step when battery voltage triggers the BAT\_OVP\_ALM.

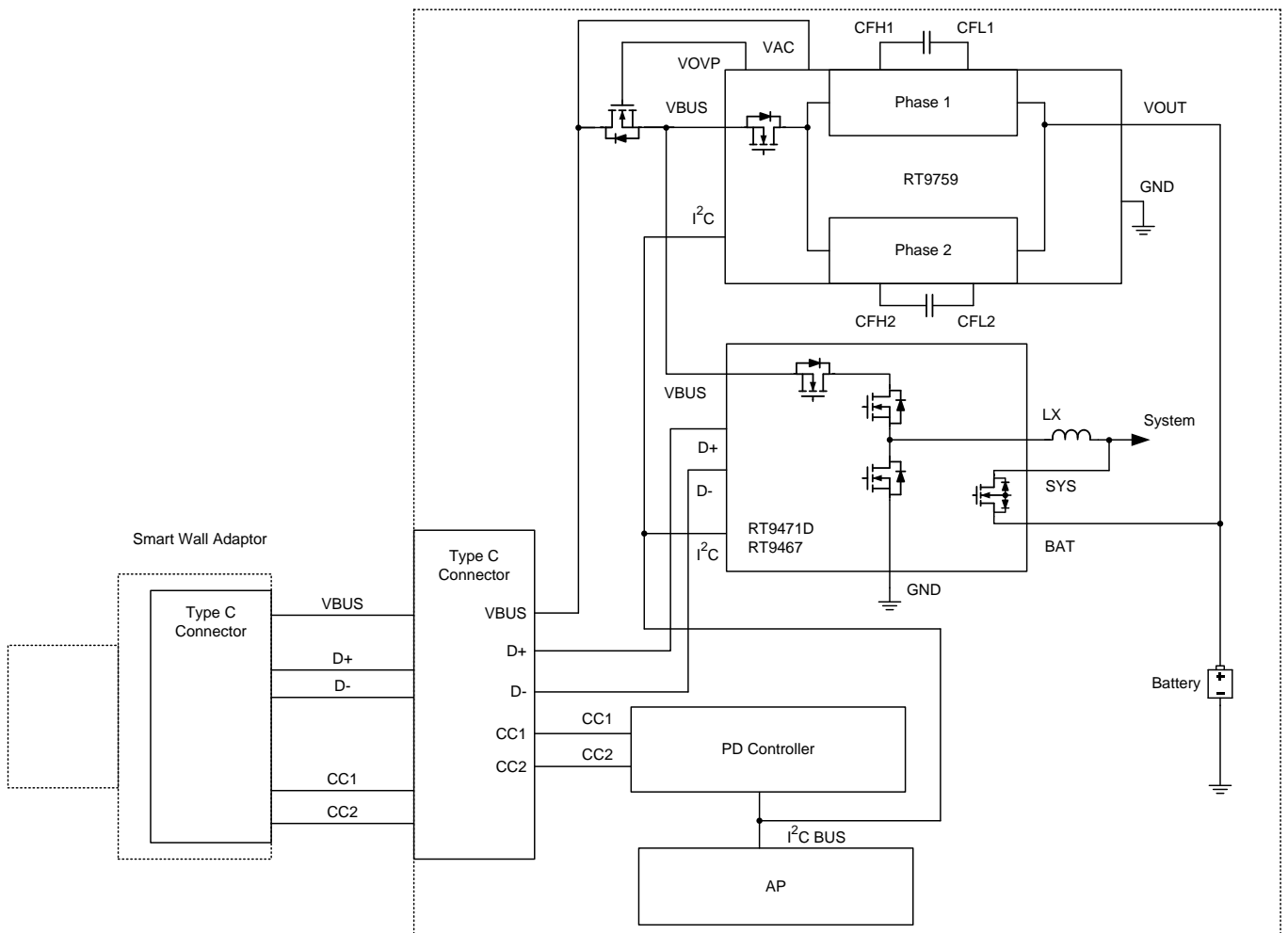


Figure 2. Simplified Charge System

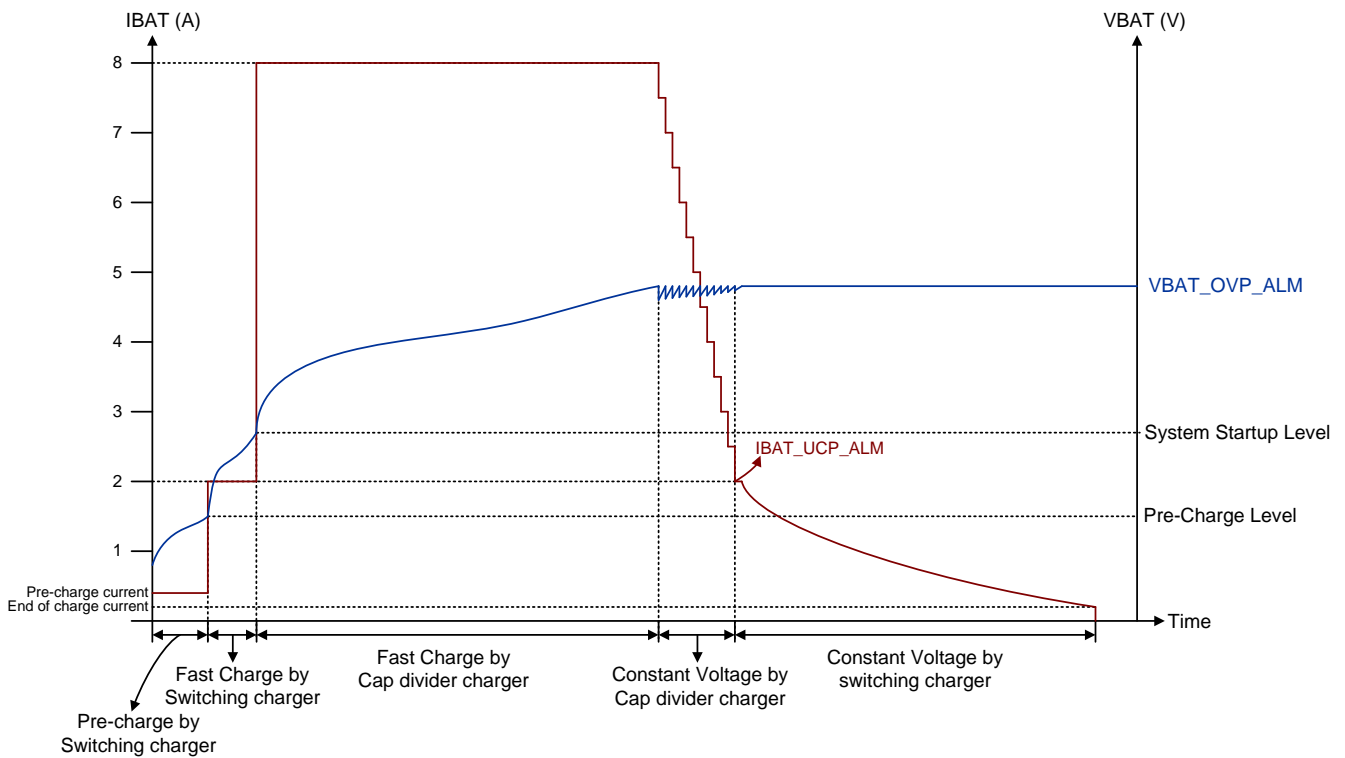


Figure 3. Charge Profile using Switching Charger and Cap Divider Charger

While the RT9759 is charging, host needs to communicate with smart wall adapter to control the charging current provided by the RT9759. The communication flow between smart wall adapter and charge system is shown in Figure 4. In order to prevent abnormal events when charging, the RT9759 is established with many adjustable protections and alarm functions. All alarms and protections are activated in specific operation condition that are shown in Table 2 and Table 4, respectively.

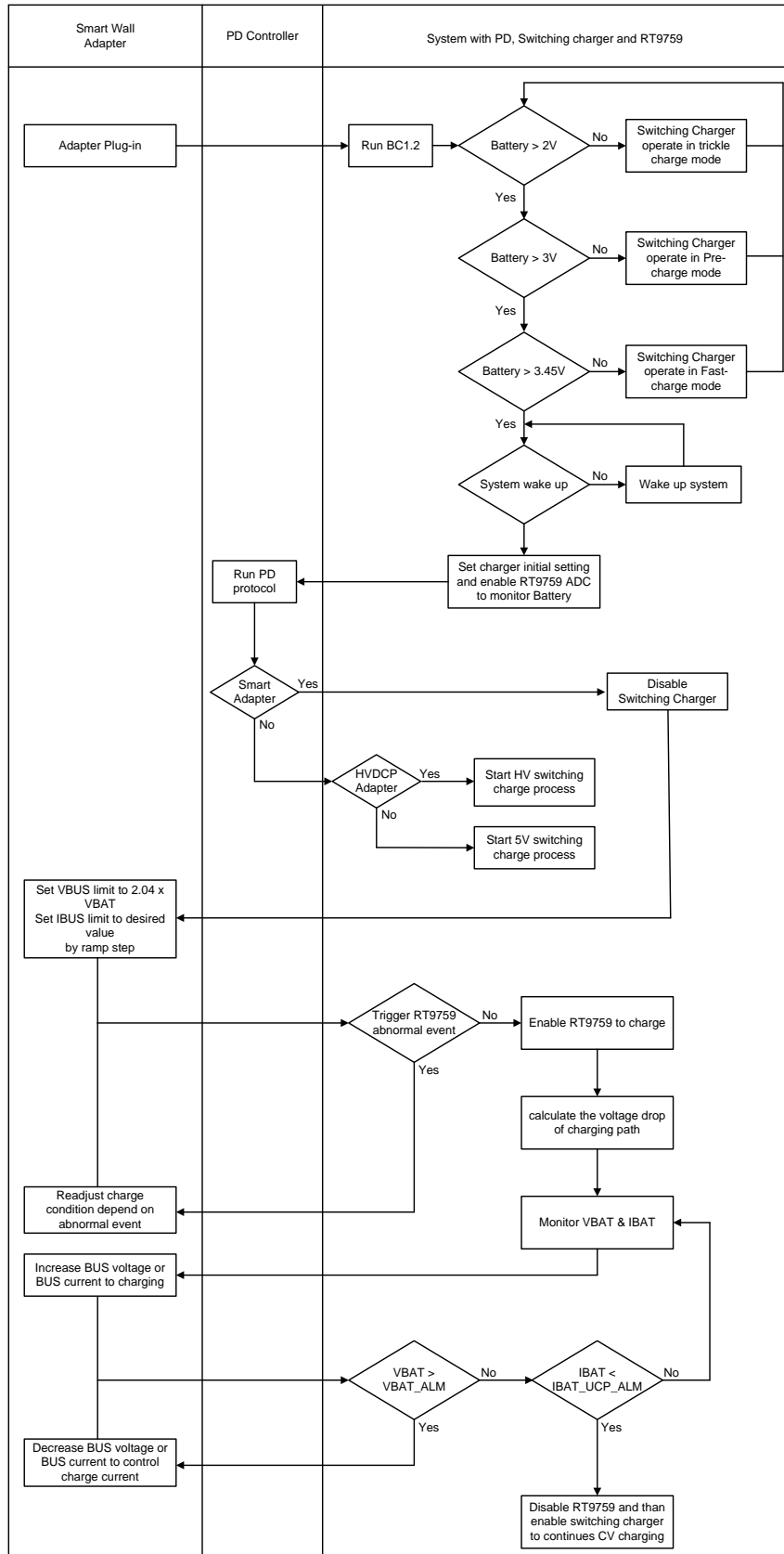


Figure 4. System Control Flow Chart

**Device Power Up**

The device is powered by VDDA. When VDDA voltage is higher than VDDA\_UVLO Threshold, the device will start working. The VDDA voltage can be powered by either VBUS or VOUT and that is dominated by the higher voltage level.

Once the RT9759 is powered, the device will active the address detection mechanism to assign the slave address of device and configuration mode. The slave address of device and configuration mode are determined by resistance between CDRVL\_ ADDRMS pin and GND. The criteria of CDRVL pull low resistance (R<sub>CDRVL</sub>) is shown in electrical characteristics list. After address detection is finished, the host can communicate with the RT9759 by I<sup>2</sup>C serial interface. Furthermore, the reaction time during VDDA > VDDA\_UVLO to I<sup>2</sup>C release (t<sub>VDDA\_START</sub>) is around 64 msec.

The RT9759 includes a watch dog timer that is enabled by default. If the device is not read or written before watch dog timer timeout, only the ADC\_EN and CHG\_EN will be set to default value. Moreover, the watchdog timeout flag and /INT pulse will be triggered to inform the host.

If the VOUT is not higher than VOUT\_INSERT rising threshold, the charge can't be enabled. Once VOUT

exceeds VOUT\_INSERT rising threshold, the minimum allowable VOUT for enable charge is VOUT\_INSERT falling threshold. Before charge enable, the RT9759 can report ADC information while the ADC is enabled. After charge enable, the RT9759 still can report ADC information whether the ADC is enabled or not.

In order to reduce quiescent current, most of sensing circuit inside the RT9759 will be turned off after address detection is finished and ADC\_EN and CHG\_EN are disabled for 500ms. In other words, part of protections and insert function are still activated before disabling device sensing circuit. The Figure 5 shows the device power on flow with protections and insert function activation list in each state. The VBAT\_OVP, VOUT\_OVP, VBUS\_OVP, TDIE\_OTP, VBUS\_HIGH\_ERR, VBUS\_LOW\_ERR, VOUT\_INSERT and VAC\_INSERT function are still active before sensing circuits are turned off. When the device disable sensing circuit, all of protections and VOUT\_INSERT are disabled except VAC\_INSERT. Because the VAC\_OVP function is independent circuit inside the RT9759, the activation state about VAC\_OVP is excluded in Figure 5 and the detail about VAC\_OVP will be described in protection feature section.

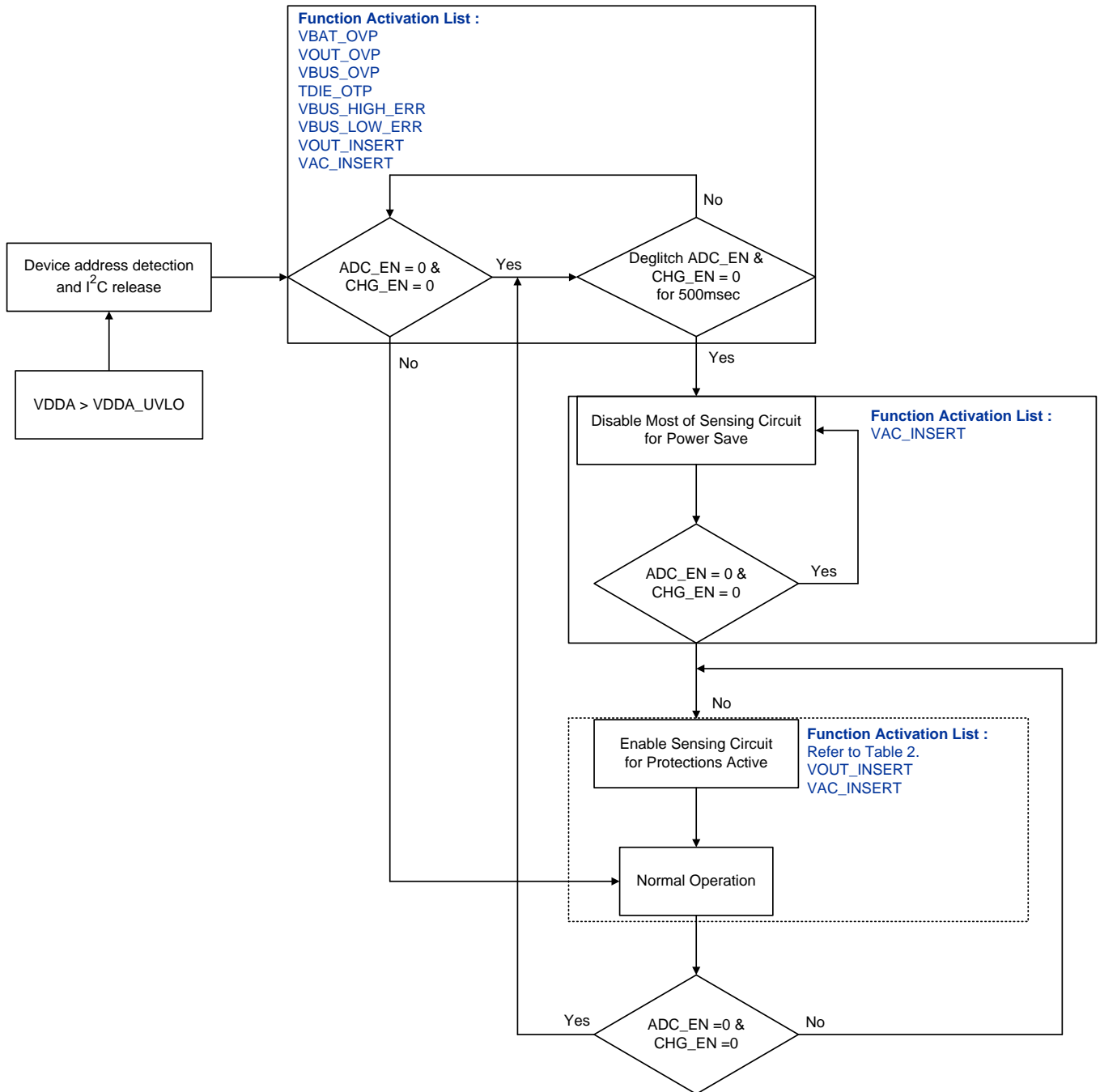


Figure 5. Device Power On Flow with Protections and Insert Function Activation List

**9-Channel Analog to Digital Converter**

The RT9759 integrates 9-Channel ADC conversion for users to monitor input and output status of the device. The ADC function is allowed to operate if  $VDDA > VDDA_{UVLO}$ . Without this condition, the RT9759 will reset  $ADC\_EN$  to disable. The ADC function can operate in continuous mode or 1-shot mode. Users can enable ADC function and select conversion mode via I<sup>2</sup>C serial interface control (0x0C). In continuous mode, the ADC function will convert all ADC channel and report ADC data to related registers (0x16 to 0x27) continuously. In 1-shot mode, ADC function will reset  $ADC\_EN$  bit to 0 after converting each ADC channel.

Each ADC channel can be enabled or disabled via I<sup>2</sup>C serial interface control (0x14 to 0x15). The device uses ADC conversion data to detect all alarm function,  $TSBAT\_OTP$  and  $TSBUS\_OTP$  protection. Due to this feature, the ADC function will be forced to convert each ADC channel with continuous mode and ADC cannot be controlled via register after charging. The Figure 6 is ADC function operation flow chart; Users can follow the flow chart to control ADC function. While reading the data of registers 0x16 to 0x27, high byte has to be read firstly, and then the following is low byte. Moreover, high byte and low byte have to be read with I<sup>2</sup>C multi-byte reading method in one transmission, which is terminated with one STOP condition.

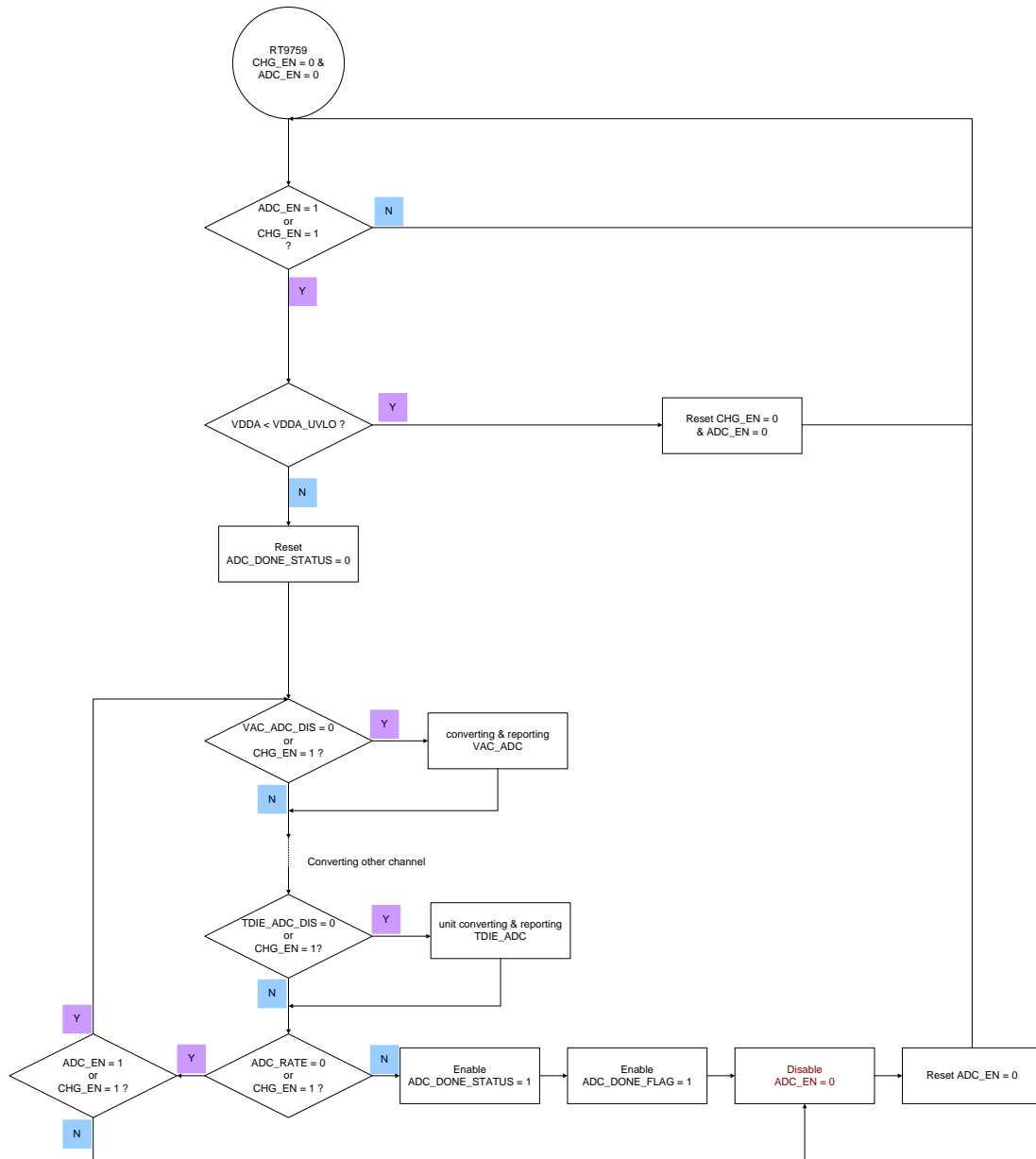


Figure 6. ADC Function Operation Flow Chart



**Protection Feature**

The RT9759 integrates 15 protections to protect device charging in unexpected condition. All protection activations are based on CHG\_EN and ADC\_EN bit except VAC\_OVP. Users need to set CHG\_EN or ADC\_EN bit to 1 to enable related protection. Table 2 shows the enable condition and protect method for each protection.

**Table 2. Protection Function Activation List**

| Protection Function | Enable Condition                            | Protection Method                |
|---------------------|---|----------------------------------|
| VAC_OVP             | VAC > VAC_INSERT                            | Turn off Q1 and Reset CHG_EN = 0 |
| VBUS_OVP            | CHG_EN = 1 or ADC_EN = 1                    | Reset CHG_EN = 0                 |
| VBAT_OVP            | CHG_EN = 1 or ADC_EN = 1                    | Reset CHG_EN = 0                 |
| VOUT_OVP            | CHG_EN = 1 or ADC_EN = 1                    | Reset CHG_EN = 0                 |
| IBUS_OCP            | CHG_EN = 1                                  | Reset CHG_EN = 0                 |
| IBUS_UCP            | CHG_EN = 1                                  | Reset CHG_EN = 0                 |
| IBAT_OCP            | CHG_EN = 1                                  | Reset CHG_EN = 0                 |
| TDIE_OTP            | CHG_EN = 1 or ADC_EN = 1                    | Reset CHG_EN = 0                 |
| TSBUS_OTP           | CHG_EN = 1 or ADC_EN = 1                    | Reset CHG_EN = 0                 |
| TSBAT_OTP           | CHG_EN = 1 or ADC_EN = 1                    | Reset CHG_EN = 0                 |
| VDR_OVP             | CHG_EN = 1                                  | Reset CHG_EN = 0                 |
| CFLY_DIAG           | CHG_EN = 1                                  | Reset CHG_EN = 0                 |
| CON_OCP             | CHG_EN = 1                                  | Reset CHG_EN = 0                 |
| VBUS_LOW_ERR        | CHG_EN = 1 (before switching) or ADC_EN = 1 | Reset CHG_EN = 0                 |
| VBUS_HIGH_ERR       | CHG_EN = 1 (before switching) or ADC_EN = 1 | Reset CHG_EN = 0                 |

• **VAC Pin Over-Voltage Protection (VAC\_OVP)**

The RT9759 integrates VAC\_OVP function to monitor adaptor voltage by VAC pin and control external MOSFET by OVPGATE pin. The VAC\_OVP function is powered by VAC pin, it will be enabled if VAC voltage is higher than VAC\_INSERT. The device will provide a VOVPGATE voltage to turn on external MOSFET if VAC is higher than VAC\_INSERT for a tVAC\_INSERT\_DEG time. If the VAC voltage is higher than VAC\_OVP threshold, the device will start to turn off external MOSFET after a tVAC\_OVP\_RE time and it will turn off the external MOSFET within tVAC\_OVP\_OFF time. The Figure 7 shows the timing of VAC\_OVP function. Users should make sure the adaptor voltage will not be higher than absolute maximum rating of VAC pin and external MOSFET (prevented by external TVS or...etc.).

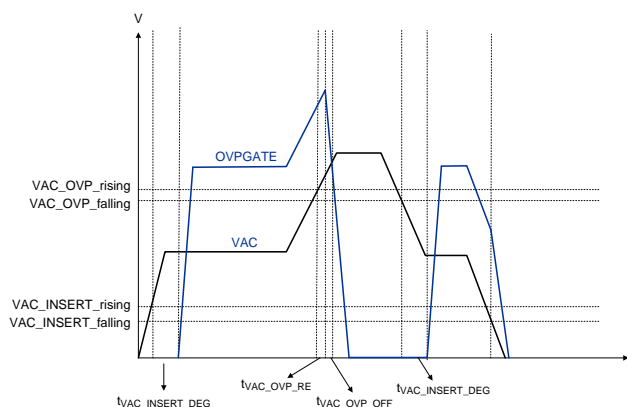


Figure 7. OVPGATE Operation Timing

- **VBUS Charge Voltage Protection (VBUS\_HIGH\_ERR and VBUS\_LOW\_ERR)**

The device integrates VBUS\_HIGH\_ERR and VBUS\_LOW\_ERR to prevent users from adjusting wrong VBUS for charge. In no charge condition, if VBUS is higher than VBUS\_HIGH\_ERR threshold or VBUS lower than VBUS\_LOW\_ERR threshold, the device will force CHG\_EN bit to disable. Both of VBUS\_HIGH\_ERR and VBUS\_LOW\_ERR will be disabled after the device successfully start to charge.

- **Input and Output Over-Voltage Protection (VBUS\_OVP, VOUT\_OVP, VBAT\_OVP)**

The device has VBUS\_OVP, VBAT\_OVP and VOUT\_OVP function to detect input and output charge voltage condition. If input and output charge voltage is higher than protection threshold, the device will turn off charger and reset CHG\_EN to disable. The VBUS\_OVP function monitors VBUS voltage by VBUS pin and the VOUT\_OVP function monitors VOUT voltage by VOUT pin. In high charging current application, the EVB might have large voltage drop between the device and battery pack. For the application, the device integrates VBAT\_OVP to monitor differential voltage between B ATP and BATN. Users should connect 100Ω with B ATP and BATN to battery pack to achieve remote sense for the device. Users can adjust the protected threshold of VBUS\_OVP and VBAT\_OVP by I<sup>2</sup>C serial interface.

- **Input and Output Over-Current Protection (IBUS\_OCP, IBAT\_OCP)**

The IBUS\_OCP function monitors input current via Q0. If CHG\_EN bit is enabled, the Q0 will turn on and IBUS\_OCP will start detecting input current. If the IBUS is larger than IBUS\_OCP threshold the device will stop charging and reset CHG\_EN bit to disable. The IBAT\_OCP function detect battery current via SRP and SRN pin. Users should connect a 2mΩ in series with battery pack. The SRN and SRP should connect on the resistor in parallel. The internal protector will convert the differential voltage of SRP and SRN to current value. The ratio between the differential voltage and current value can be determined by register setting. If the current value is larger than IBAT\_OCP threshold, the device will stop

charging and reset CHG\_EN to disable. Users can adjust the IBUS\_OCP and IBAT\_OCP threshold via register setting.

- **Input Under-Current Protection (IBUS\_UCP)**

The device integrates IBUS\_UCP function to prevent reverse current from battery to VBUS. The IBUS\_UCP detect input current by Q0. The Figure 8 shows the flow chart of IBUS\_UCP, the device enables IBUS\_UCP\_RISE threshold and counting timer after start charging. Once IBUS is larger than IBUS\_UCP\_RISE threshold, the device will stop counting timer and enable IBUS\_UCP\_FALL threshold. If the IBUS is smaller than IBUS\_UCP\_RISE and the timer already longer than IBUS\_UCP\_TIMEOUT, the device will enable IBUS\_UCP\_FALL threshold. After the device enables IBUS\_UCP\_FALL threshold, if the IBUS is smaller than IBUS\_UCP\_FALL threshold, the device will stop charging and reset CHG\_EN to disable. The Figure 9 shows IBUS\_UCP behavior in different application.

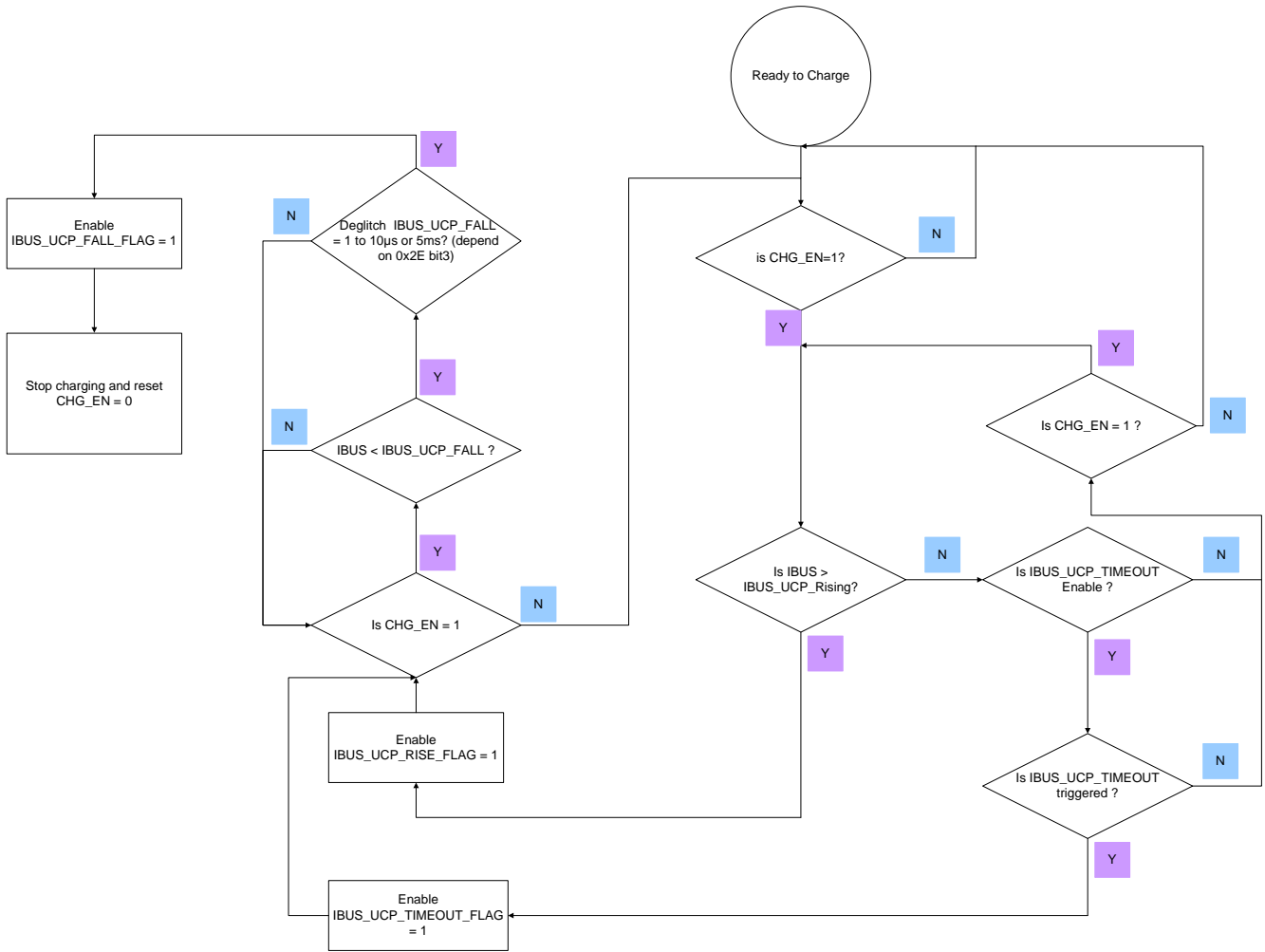


Figure 8. Flow Chart of IBUS\_UCP Function

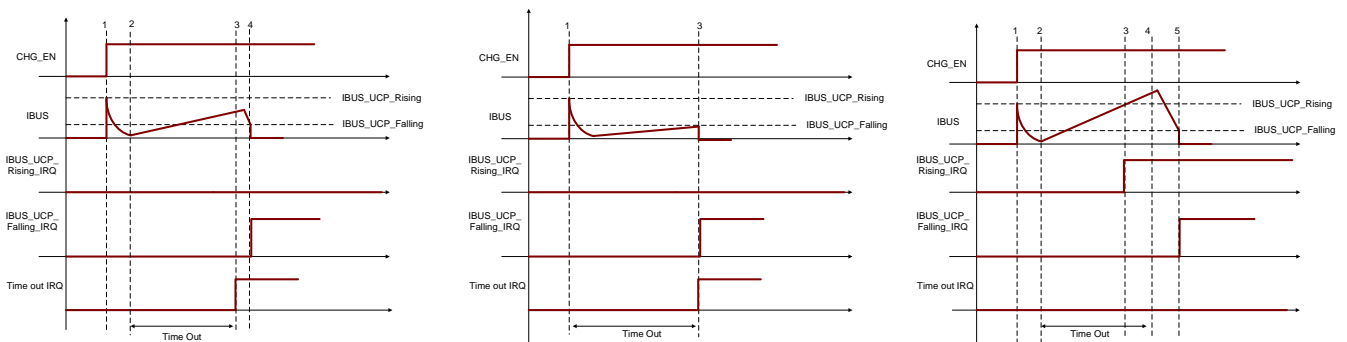
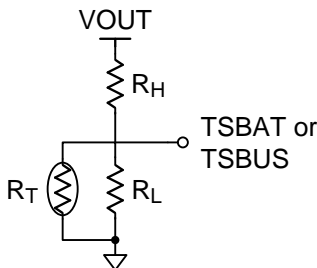


Figure 9. IBUS\_UCP Behavior in Different Application

• **Device Thermal Shutdown (TDIE\_OTP), BUS and BAT Over-Temperature Protection**

The device integrates TDIE\_OTP, TSBAT\_OTP and TSBUS\_OTP to prevent system charging in over-temperature condition. The TDIE\_OTP function monitors die temperature of the device. If the die temperature is higher than TDIE\_OTP threshold, the device will stop charging and reset CHG\_EN bit to disable.

The device monitors BUS connector and battery pack temperature by the voltage of TSBUS and TSBAT pin. Users should connect resistor divider on TSBAT and TSBUS pin. Both resistor divider should be pulled up to VOUT and a negative coefficient thermistor is parallel with the low side resistor. The protection threshold of TSBUS\_OTP and TSBAT\_OTP are according to TSBUS\_ADC, TSBAT\_ADC and VOUT\_ADC data. Users should not disable TSBUS\_ADC, TSBAT\_ADC, VOUT\_ADC if TS protection is active. The protection threshold is determined by the following equation. If the TS percentage is higher than protection threshold, the device will stop charging and reset CHG\_EN to disable.



$$TSV_{BUS} \text{ or } TSBAT (\%) = \frac{1}{R_H + \frac{1}{\left(\frac{1}{R_L} + \frac{1}{R_T}\right)}}$$

• **Flying Capacitor Diagnose (CFLY\_DIAG)**

The device integrates CFLY\_DIAG function to diagnose the health of flying capacitors. After CHG\_EN is enabled, the device starts soft-start process in tSOFT\_START. In the soft-start process, the CFLY\_DIAG function will diagnose the resistance between CFL and CFH for each phase. If the resistance is smaller than R\_CFLY\_DIAG, the device will

stop soft-start process and reset CHG\_EN to disable. If the device succeeds to start charging after soft-start process, the CFLY\_DIAG function will stop activating. If the CFLY is short after soft-start, the device can be protected by other protections (ex. IBUS\_OCP, VBAT\_OVP, VOUT\_OVP, CON\_OCP....).

• **Converter Over-Current Protection (CON\_OCP)**

The device integrates CON\_OCP function to detect the converter operating current. If the converter operating current is larger than CON\_OCP threshold, the device will stop charging and reset CHG\_EN to disable.

• **Dropout Voltage Protection (VDR\_OVP)**

When VBAT\_REG or IBAT\_REG is activated, it might cause a large voltage drop on external MOSFET. The large voltage drop might cause high power loss and a lot of heat in the system. In order to prevent the situation, the device integrates VDR\_OVP function to monitor the voltage drop between VAC and VBUS pin. If the voltage drop is higher than VDR\_OVP threshold, the device will stop charging and reset CHG\_EN to disable. The threshold of VDR\_OVP can be determined by register setting.

**Regulation Feature**

The device has VBAT\_REG and IBAT\_REG regulation functions to regulate instant current change and voltage change for the battery. Users can set the regulation threshold by register setting.

The VBAT\_REG function monitors differential voltage between BATH and BATN pin. If the differential voltage is higher than VBAT\_REG threshold, the device will control OVP\_GATE voltage to regulate charge current. IBAT\_REG function convert the differential voltage between SRN and SRP to current value. If the current value is higher than IBAT\_REG threshold, the device will control OVP\_GATE voltage to regulate charge current. If the regulation functions are triggered and persist for tREG\_TIMEOUT, the device will stop charging and reset CHG\_EN to disable. When regulation functions are triggered, system should adjust charging condition to prevent the device from triggering the tREG\_TIMEOUT and VDR\_OVP.

**Alarm Feature**

The device integrates 7 alarm functions for system to monitor the charge condition. The alarm functions use the ADC conversion data to monitor the charge condition. Table 3 shows the relationship between alarm functions and ADC channels, users should make sure the ADC channel is enabled when using related alarm functions. If the alarm function is triggered, the device will send an interrupt to alarm system but charger will not stop charging. The Table 4 shows the enable condition for each alarm.

**Table 3. Alarm Function with Related ADC Channel**

| Alarm Function      | Related ADC Channel Need Enabled | Sense Node             |
|---------------------|----------------------------------|------------------------|
| VBAT_OVP_ALM        | VBAT_ADC                         | BATP and BATN pin      |
| IBAT_OCP_ALM        | IBAT_ADC                         | SRP and SRN pin        |
| IBAT_UCP_ALM        | IBAT_ADC                         | SRP and SRN pin        |
| VBUS_OVP_ALM        | VBUS_ADC                         | VBUS pin               |
| IBUS_OCP_ALM        | IBUS_ADC                         | Q0                     |
| TDIE_OTP_ALM        | TDIE_ADC                         | DIE temperature        |
| TSBUS_TSBAT_OTP_ALM | TSBAT_ADC, TSBUS_ADC, VOUT_ADC   | TSBAT, TSBUS, VOUT pin |

**Table 4. Alarm Function Activation List**

| Alarm Function      | Enable Condition        |
|---------------------|-------------------------|
| VBUS_OVP_ALM        | CHG_EN = 1 or ADC_EN =1 |
| VBAT_OVP_ALM        | CHG_EN = 1 or ADC_EN =1 |
| IBUS_OCP_ALM        | CHG_EN = 1              |
| IBAT_OCP_ALM        | CHG_EN = 1              |
| IBAT_UCP_ALM        | CHG_EN = 1              |
| TDIE_OTP_ALM        | CHG_EN = 1 or ADC_EN =1 |
| TSBUS_TSBAT_OTP_ALM | CHG_EN = 1 or ADC_EN =1 |

**I<sup>2</sup>C serial Interface**

The RT9759 integrates I<sup>2</sup>C interface for host to program charging parameter and monitor device status. The interface requires a serial clock line (SCL) and a serial data line (SDA). The host should initiate a data transfer on the bus and generates the clock signals to permit that transfer. The device operates with address 66H or 65H to receive control input from the host. The SCL and SDA pin are open drain structures. Users should connect a supply voltage via a current source or pull-up resistors on SCL and SDA. The Figure 10 shows the I<sup>2</sup>C waveform information, the data line must be stable during the high period of SCL line. The high or low state of SDA can only change when SCL line is low.

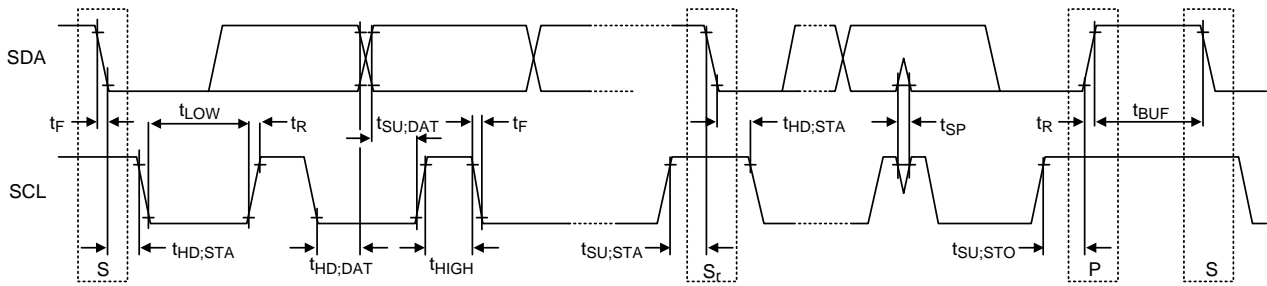


Figure 10. I<sup>2</sup>C Waveform Information

The RT9759 operates as an I<sup>2</sup>C slave device with address 66H or 65H (depends on pull low resistance of CDRVL). Every byte on SDA line must be 8 bit long. The Figure 11 shows the byte format of SDA and SCL line. All of transactions begin with a START pattern and can be terminated with a STOP pattern. After START, the master should send a slave address. The slave address is 7-bits long followed by the eighth bit as a data direction bit (R/W). The direction bit setting to 0 indicates a transmission and 1 indicates a request for data. The master should take an acknowledge bit after every byte. The master should release SDA line during the acknowledge clock pulse so the slave device can pull low the SDA line to signal the master that the byte was successfully received. The RT9759 supports multi read/write and SCL line can be up to 3.4MHz.

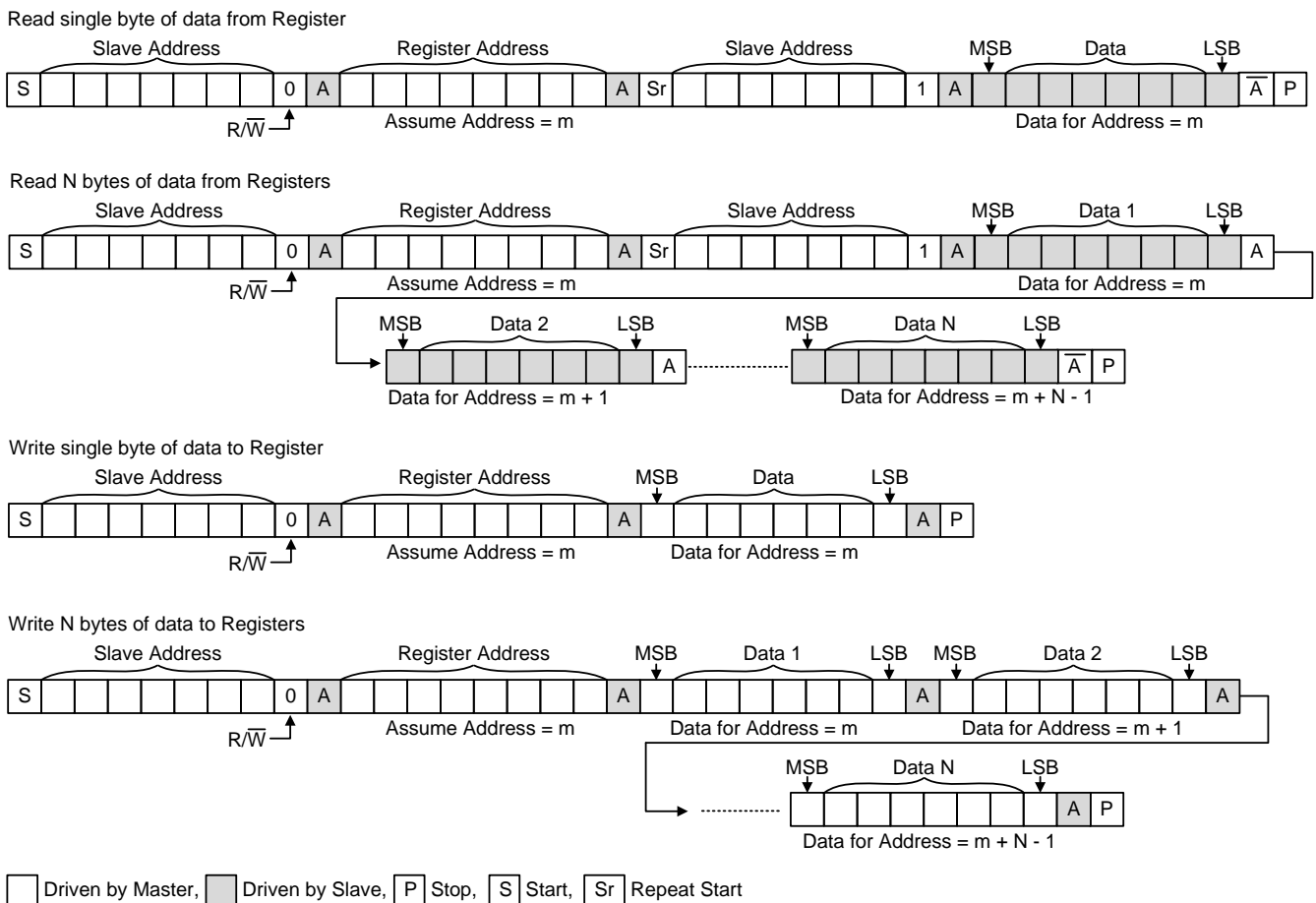


Figure 11. Read and Write Function

**Interrupt (INT), STAT, FLAG AND MASK**

The INT pin is an open drain structure; users should connect a supply voltage via a current source or pull-up resistors on the pin. When the device triggers an event, the INT pin will pull low for  $t_{INT}$  to notify host. The register map shows all state, flag and control bit of the device.

When the device triggers the event with FLAG, it will send an INT signal to host and set the FLAG bit to 1. The FLAG bit can be cleared after read. The device will not send another INT signal until the FLAG is cleared and a new event occurs again. The MASK bit can disable INT pin to send a signal to host. The STAT and FLAG bit are still updated even though the MASK bit is set to 1.

The STAT bits show current status of the device and are updated as the status change. All of STAT bits will not send INT signal to system when the STAT bit is triggered except SWITCHING\_STAT.

**Spread Spectrum**

The device integrated spread spectrum function for users to optimize the EMI influence on system design. The device switching frequency is decided by register 0x0B. The spectral density will concentrate on the switching frequency. Users can enable the spread spectrum function by set 0x0C register. After the spread spectrum function is enabled, the device will modulate the switching frequency for  $\pm 16\%$  to reduce the spectral density.

**Parallel Application**

For high capacity battery charging application, it is available to use two RT9759 in parallel architecture. The advantages of using parallel architecture are reducing cable losses, improve efficiency of charge system and cut down charging period. The high power solution that uses two RT9759 are shown in Figure 12. The address and configuration mode can be configured by CDRVL\_ADDRMS pin while device powers up.

In order to avoid unstable ripple issue while charging with parallel architecture, the RT9759 is established with synchronization function at the TSBAT\_SYNCOUT pin and B ATP\_SYNCIN pin. The TSBAT\_SYNCOUT pin provides synchronization pulses with frequency

equal to twice switching frequency and 50% duty cycle. The B ATP\_SYNCIN pin is used to receive pulses for synchronization.

The TSBAT\_SYNCOUT pin and B ATP\_SYNCIN pin are multi-function pins that depends on different configuration. While the RT9759 is set as master (RT9759\_M), the TSBAT\_SYNCOUT pin is set as synchronization output and B ATP\_SYNCIN pin is set as battery positive sense. While the RT9759 is set as slave (RT9759\_S), the TSBAT\_SYNCOUT pin is set as TSBAT function and the B ATP\_SYNCIN pin is set as synchronization input.

In parallel application, only master device's OVP MOSFET is used. Furthermore, the OVPGATE function and battery current sensing function are turned off in slave device. If the RT9759s are used to charge in parallel application, the slave device's OVPGATE, SRP and SRN pin can be left floating.

If parallel architecture is used, the start-up sequence should be compiled with the rules below. The RT9759 set as slave (RT9759\_S) should be enabled before host enables the RT9759 set as master (RT9759\_M) in order to achieve parallel application. The RT9759\_S will not switch until the B ATP\_SYNCIN pin receives synchronization pulses provided by the RT9759\_M. The communication flow between smart wall adapter and parallel charge system is shown in Figure 13.

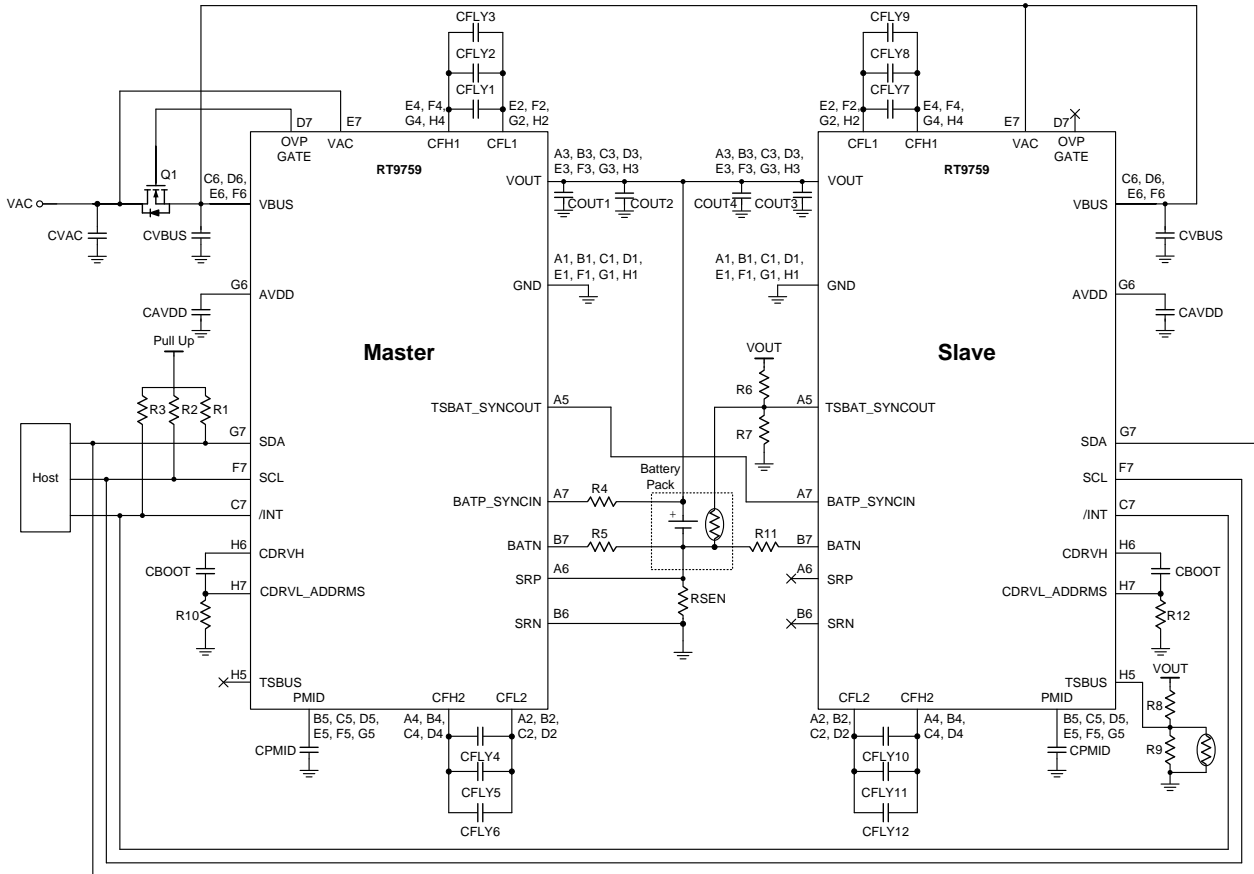


Figure 12. Parallel Application Circuit



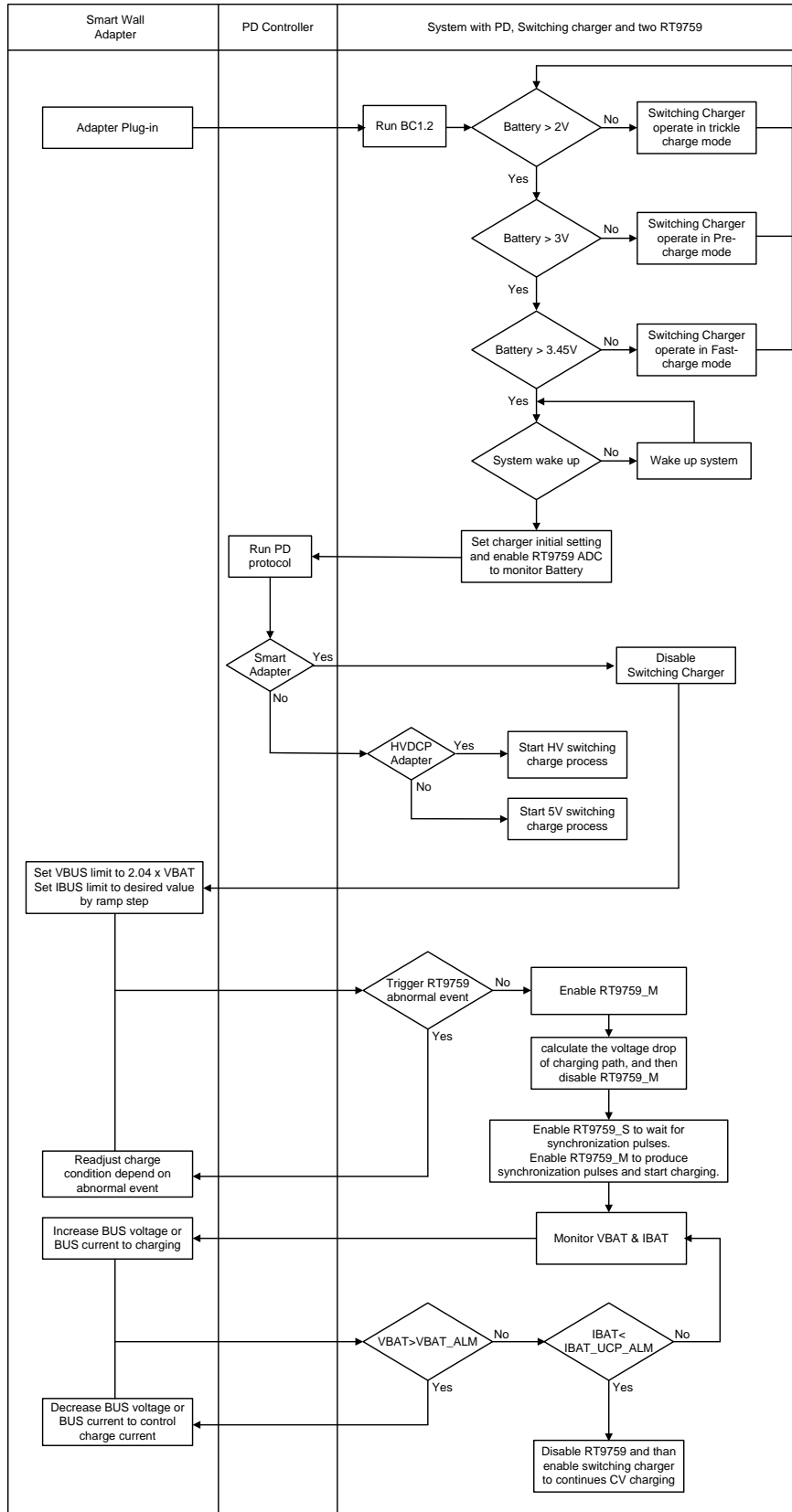


Figure 13. System Control Flow Chart with Parallel Charge system

## Thermal Considerations

The junction temperature should never exceed the absolute maximum junction temperature  $T_{J(MAX)}$ , listed under Absolute Maximum Ratings, to avoid permanent damage to the device. The maximum allowable power dissipation depends on the thermal resistance of the IC package, the PCB layout, the rate of surrounding airflow, and the difference between the junction and ambient temperatures. The maximum power dissipation can be calculated using the following formula :

$$P_{D(MAX)} = (T_{J(MAX)} - T_A) / \theta_{JA}$$

where  $T_{J(MAX)}$  is the maximum junction temperature,  $T_A$  is the ambient temperature, and  $\theta_{JA}$  is the junction-to-ambient thermal resistance.

For a continuous operation, the maximum operating junction temperature indicated under Recommended Operating Conditions is 125°C. The junction-to-ambient thermal resistance,  $\theta_{JA}$ , is highly package dependent. For a WL-CSP-56B 3.35x3.35 (BSC) package, the thermal resistance,  $\theta_{JA}$ , is 24°C/W on a standard JEDEC 51-7 high effective-thermal-conductivity four-layer test board. The maximum power dissipation at  $T_A = 25^\circ\text{C}$  can be calculated below :

$$P_{D(MAX)} = (125^\circ\text{C} - 25^\circ\text{C}) / (24^\circ\text{C/W}) = 4.16\text{W for a WL-CSP-56B 3.35x3.35 (BSC) package.}$$

The maximum power dissipation depends on the operating ambient temperature for the fixed  $T_{J(MAX)}$  and the thermal resistance,  $\theta_{JA}$ . The derating curves in Figure 14 allows the designer to see the effect of rising ambient temperature on the maximum power dissipation.

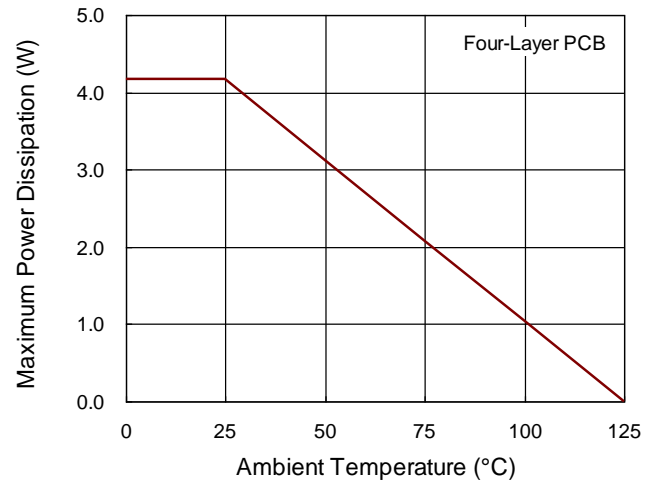


Figure 14. Derating Curve of Maximum Power Dissipation

## Layout Considerations

The RT9759 layout guidelines are recommended as below :

- ▶ Place low ESR bypass capacitor to GND for PMID/VOUT/ VBUS pin. The bypass capacitor needs to be placed as close as possible to RT9759.
- ▶ The capacitor of AVDD/CDRVL/CDRVH\_ADDR should be placed as close as possible to RT9759.
- ▶ Place flying caps with the RT9759 on same layer. The flying caps should be placed as close as possible to the RT9759. The path of flying caps should be as small as possible.
- ▶ The VBUS and VOUT traces should be as wide as possible to accommodate high charge current.
- ▶ Place differential line for VBATP/VBATN and SRP/SRN. Do not route the differential line across power pad especially the flying caps.

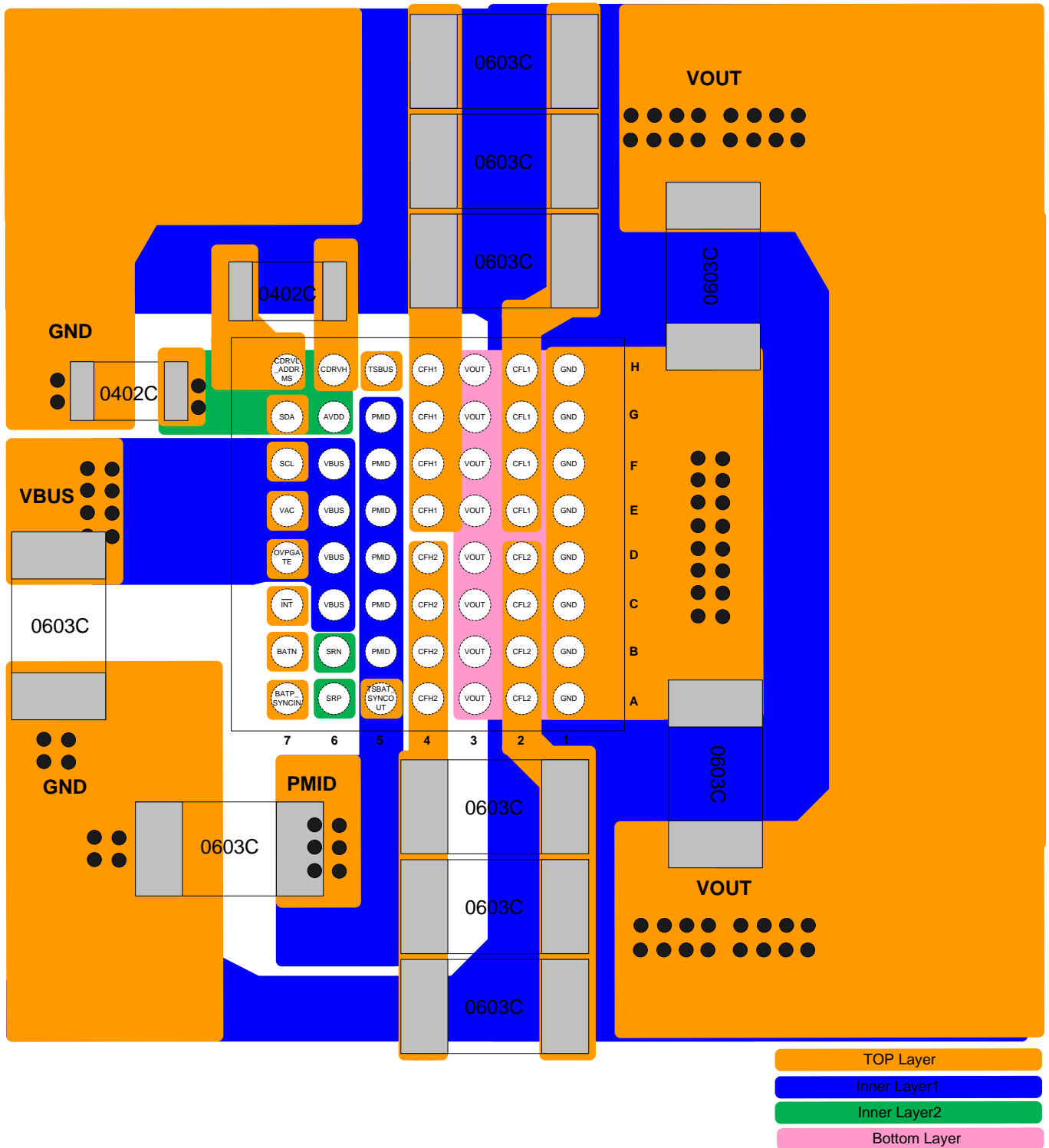
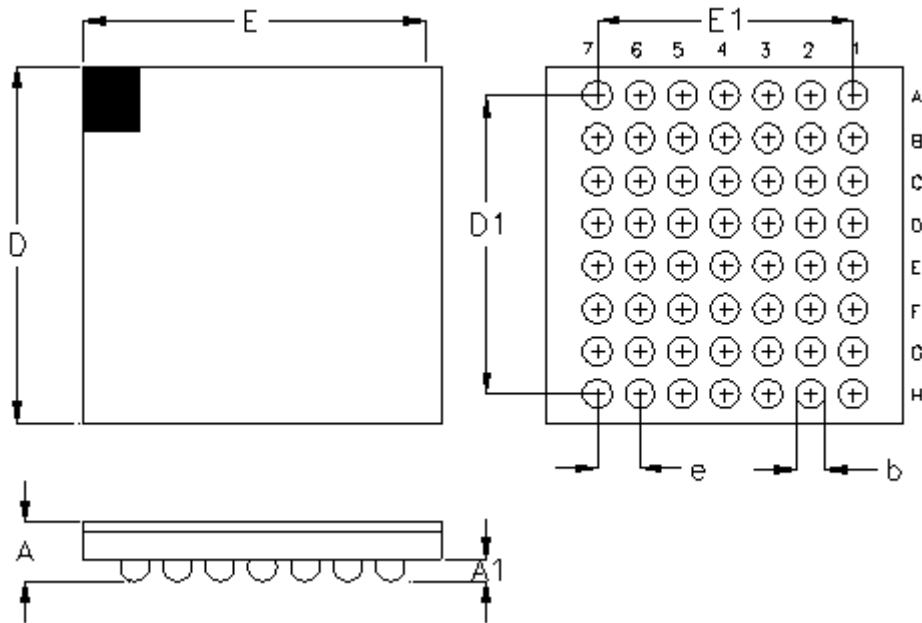


Figure 15. PCB Layout Guide

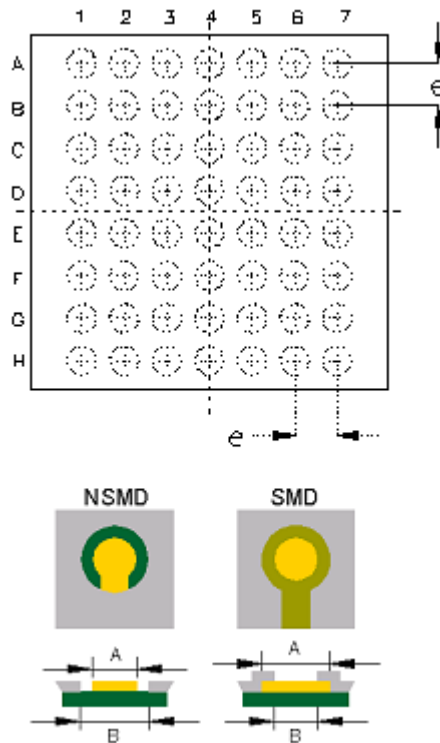
Outline Dimension



| Symbol | Dimensions In Millimeters |       | Dimensions In Inches |       |
|--------|---------------------------|-------|----------------------|-------|
|        | Min                       | Max   | Min                  | Max   |
| A      | 0.500                     | 0.600 | 0.020                | 0.024 |
| A1     | 0.170                     | 0.230 | 0.007                | 0.009 |
| b      | 0.240                     | 0.300 | 0.009                | 0.012 |
| D      | 3.310                     | 3.390 | 0.130                | 0.133 |
| D1     | 2.800                     |       | 0.110                |       |
| E      | 3.310                     | 3.390 | 0.130                | 0.133 |
| E1     | 2.400                     |       | 0.094                |       |
| e      | 0.400                     |       | 0.016                |       |

56B WL-CSP 3.35x3.35 Package (BSC)

**Footprint Information**



| Package                 | Number of Pin | Type | Footprint Dimension (mm) |       |       | Tolerance |
|-------------------------|---------------|------|--------------------------|-------|-------|-----------|
|                         |               |      | e                        | A     | B     |           |
| WL-CSP3.35x3.35-56(BSC) | 56            | NSMD | 0.400                    | 0.240 | 0.340 | ±0.025    |
|                         |               | SMD  |                          | 0.270 | 0.240 |           |

**Richtek Technology Corporation**

14F, No. 8, Tai Yuen 1<sup>st</sup> Street, Chupei City  
 Hsinchu, Taiwan, R.O.C.  
 Tel: (8863)5526789

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